



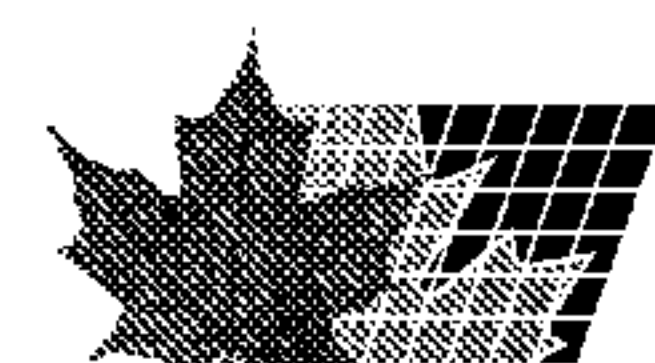
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(54) Titre : MELANGES A MOULER DE POLYAMIDE SEMI-AROMATIQUE ET LEUR UTILISATION
(54) Title: SEMIAROMATIC POLYAMIDE MOLDING COMPOSITIONS AND THEIR USE

(57) **Abrégé/Abstract:**

A polyamide molding composition with the following constitution is described: (A) from 30 to 100% by weight of at least one 10T/6T copolyamide, where this is composed of (A1) from 40 to 95 mol% of 10T units, formed from the monomers 1,10-decanediamine and terephthalic acid (A2) from 5 to 60 mol% of 6T units, formed from the monomers 1,6-hexanediamine and terephthalic acid (B) from 0 to 70% by weight of reinforcing materials and/or fillers (C) from 0 to 50% by weight of additives and/or further polymers where the entirety of components A to C is 100%, with the proviso that in component (A) up to 30 mol%, based on the entirety of the dicarboxylic acids, of the terephthalic acid can have been replaced by other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids, and with the proviso that in component (A) up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, can have been replaced by other diamines, and with the proviso that not more than 30 mol% in component (A), based on the entirety of the monomers, can have been formed via lactams or amino acids. Uses of this polyamide molding composition are moreover described, as also are processes for the preparation of these polyamide molding compositions.



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ABSTRACT

A polyamide molding composition with the following constitution is described:

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(A) from 30 to 100% by weight of at least one 10T/6T copolyamide, where this is composed of

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(A1) from 40 to 95 mol% of 10T units, formed from the monomers 1,10-decanediamine and terephthalic acid

(A2) from 5 to 60 mol% of 6T units, formed from the monomers 1,6-hexanediamine and terephthalic acid

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(B) from 0 to 70% by weight of reinforcing materials and/or fillers

(C) from 0 to 50% by weight of additives and/or further polymers

where the entirety of components A to C is 100%, with the proviso that in component (A) up to 30 mol%, based on the entirety of the dicarboxylic acids, of the terephthalic acid can have been replaced by other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids, and with the proviso that in component (A) up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, can have been replaced by other diamines, and with the proviso that not more than 30 mol% in component (A), based on the entirety of the monomers, can have been formed via lactams or amino acids. Uses of this polyamide molding composition are moreover described, as also are processes for the preparation of these polyamide molding compositions.

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(Fig. 1)

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DESCRIPTION

TITLE

Semiaromatic polyamide molding compositions and
their use

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TECHNICAL FIELD

The present invention relates to polyamide molding
compositions based on a terephthalic acid copolyamide
and to processes for their preparation, and to uses
10 thereof.

PRIOR ART

Known standard polyamides, such as PA6 and PA66, are
easy to process, and have high melting points and high
15 heat deflection temperatures, particularly when they
have glass-fiber reinforcement or comprise mineral
fillers. However, they typically have high water
absorptions up to 10% on storage in water. For many
applications with stringent requirements for
20 dimensional stability, including under wet or moist
conditions, these aliphatic polyamides cannot be used.
Water absorption alters not only dimensions but also
mechanical properties. Water absorption reduces
stiffness values and strength values to a fraction of
25 their previous levels. In other words, problems arise
when the standard polyamides are used in applications
with mechanical load in contact with water or ambient
moisture.

30 Long-chain aliphatic polyamides composed of
aminoundecanoic acid (PA11) or laurolactam (PA12), or
composed of dodecanediamine and dodecanedioic acid
(PA1212) have low water absorption but have undesirably
low melting points below 200°C. PA11, PA12, and PA1212
35 have low modulus and strength, even when dry. They are
unsuitable for technical applications at relatively
high temperatures.

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2

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Semiaromatic polyamides of PA6T/6I type, as described in US 4,607,073 have reduced water absorption when compared with PA6 and PA66, and mechanical properties are substantially retained after water absorption.

5 However, water absorption is still too high for precision parts (swelling), melting points are likewise too high, and the use of isophthalic acid markedly lowers crystallinity and crystallization rate, and there are problems with processability.

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On the other hand, PA10T, as likewise disclosed in US 4,607,073, has markedly reduced water absorption, and mechanical properties do not change on storage in water. The material is highly crystalline, and
15 crystallizes very rapidly, a result being freezing within the nozzle during injection molding. Glass-fiber-reinforced PA10T has very irregular surfaces.

Semiaromatic polyamides of PA6T/NDT/INDT type, as
20 described in US 4,617,342, or of PA6T/6I/66 type as described in USRE34447E, or of PA6T/6/66 type as in EP 0 299 444, or of PA6T/MPMDT type as in EP 0 522 027 and EP 0 561 886 have reduced water absorption when comparison is made with PA6 and PA66, and mechanical
25 properties are retained after water absorption. However, here again water absorption is still too high for precision parts (swelling). According to US 5,098,940, the polyphthalamides of the US RE34447E mentioned and of the likewise abovementioned
30 US 4,617,342 also have long cycle times in injection molding and require high mold temperatures which cannot be achieved using water-heated molds.

The specification EP 0 659 799, EP 0 976 774,
35 EP 1 186 634, and EP 1 375 578 describe semiaromatic polyamides composed of from 60 to 100 mol% of terephthalic acid and from 60 to 100 mol% of a diamine component composed of 1,9-nonanediamine and 2-methyl-

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3

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1,8-octanediamine. These products feature good processability, excellent crystallinity, good heat deflection temperature, low water absorption, good chemicals resistance, and dimensional stability, and toughness. However, 2-methyl-1,8-octanediamine is currently not listed in the regulations either for existing substances or for new substances, and is therefore not approved in Europe. This inhibits rapid product introduction in the European market.

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The documents EP 1 710 482, EP 1 741 549, and EP 1 741 553 claim multilayer pipes and multilayer hoses for the transport of chemicals and/or gases at high temperatures and multilayer structures with a semiaromatic polyamide composed of from 60 to 100 mol% of an aliphatic diamine having from 9 to 13 carbon atoms and from 50 to 100 mol% of terephthalic acid and/or naphthalenedicarboxylic acid. The examples use PA9T, PA9N, PA12T, and PA12N, in each case with 100 mol% of aliphatic diamine having from 9 to 12 carbon atoms. The description points out that other diamines, e.g. hexamethylenediamine, can be used within a range in which the excellent properties of the multilayer tubes, multilayer pipes, or multilayer structures are not impaired, and in an amount which is preferably 10 mol% or less.

EP 0 368 281 involves blends of ethylene-glycidyl methacrylate copolymer optionally with polyarylate and with a polyamide, prepared from an aliphatic or alicyclic diamine and from an aromatic dicarboxylic acid. Terephthalic acid is particularly emphasized as aromatic dicarboxylic acid. In relation to the aliphatic, linear or branched diamine having from 4 to 25 carbon atoms, said document mentions an enormous variety of possibilities. In the context of the enormous variety of possibilities mentioned, there is no express indication that the individual members of

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4

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said list can also be used in the form of a mixture. If the specific examples in said document are examined, it is found that they disclose exclusively systems based on 1,6-hexanediamine, terephthalic acid, and isophthalic acid, or adipic acid (PA6T/6I and PA6T/66).

EP 0 697 429 very generally describes copolyamides based on aliphatic diamines having from 4 to 14 carbon atoms and terephthalic acid, having a particular distribution of the segments. Said document gives a wide variety of possibilities with regard to the selection of the diamine. Preferred diamines are 1,6-hexanediamine, 2-methyl-1,5-pentanediamine (MPMD), and 1,12-dodecanediamine. Preferred polyamides are PA6T/6I, PA6T/66, PA6T/6, PA6T/66/6I, PA6T/66/6, PA12T/66, PA12T/126, PA12T/6I, PA12T/12I, and PA12T/6. When the specific examples are examined, they reveal only systems with 1,6-hexanediamine, terephthalic acid, adipic acid and caprolactam.

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US 3,839,296 involves very generally systems of xT structure, where an enormous list is given for the diamine x. In the specific examples the only compound cited is always x = 1,12-dodecanediamine.

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The abstract of JP 2002293926 involves providing a copolyamide in which the diamine (component a) comprises 1,10-diaminodecane and in which, on the other hand, the diacid always comprises terephthalic acid and, if appropriate, comprises further systems, an example being a further aromatic diacid differing from terephthalic acid, or C4-20 diacids. A large list of possible diamines is moreover cited as replacement for 1,10-decanediamine, but no specific indication is given of use of a combination (mixture). The specific examples always use only 1,10-decanediamine. There is a single example (comparative example 3) that uses another diamine, replacing 1,10-decanediamine

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5

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completely by 1,6-hexanediamine in combination with terephthalic acid and adipic acid.

BRIEF DESCRIPTION OF THE INVENTION

5 The invention is therefore based inter alia on the object of providing a polyamide molding composition improved over the prior art not only with respect to mechanical properties, including under wet or moist conditions, but also with respect to processing
10 possibilities. A further intention was to provide moldings based on this molding composition, and processes for the preparation of this molding composition.

15 Accordingly, a polyamide molding composition with the following constitution is presently and specifically proposed:

- 20 (A) from 30 to 100% by weight of at least one 10T/6T copolyamide, where this is composed of
 - (A1) from 40 to 95 mol% of 10T units, formed from the monomers 1,10-decanediamine and terephthalic acid
 - 25 (A2) from 5 to 60 mol% of 6T units, formed from the monomers 1,6-hexanediamine and terephthalic acid
- (B) from 0 to 70% by weight of reinforcing materials and/or fillers
- 30 (C) from 0 to 50% by weight of additives and/or further polymers

where the entirety of components A to C is 100%.

35 Up to 30% of the monomers within component (A) can be replaced here, and this means that the above applies firstly with the proviso that in component (A), independently of one another, in (A1) and/or (A2) up to 30 mol%, based on the entirety of the dicarboxylic

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6

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acids, of the terephthalic acid can have been replaced by other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms.

5 Secondly, furthermore, the above applies with the proviso that in component (A), independently of one another, in (A1) and/or (A2) up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, can have been replaced
10 by other diamines having from 4 to 36 carbon atoms.

Finally, the above moreover applies with the proviso that not more than 30 mol% in component (A), based on the entirety of the monomers, can have been formed via
15 lactams or amino acids.

However, it is preferable that this replacement of the monomers within component (A) in accordance with the above provisos amounts to less than 20%, and preferably
20 less than 10%, and it is particularly preferable to use no such replacement at all. A further proviso that applies overall is therefore that the concentration of the entirety of the monomers which replace terephthalic acid, 1,6-hexanediamine, and 1,10-decanediamine (i.e.
25 the total proportion of other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms, and of other diamines having from 4 to 36 carbon atoms, and of lactams or aminoacids) does not exceed 30 mol%, preferably 20 mol%, in particular
30 10 mol%, based on the entirety of the monomers used in component A.

It has specifically and unexpectedly been found that precisely the abovementioned ratios of the individual
35 components in the copolyamide lead to particular properties. For example, it has been found that below a concentration of 40 mol% of 10T the melting points of the 10T/6T copolyamides rise rapidly, thus preventing

March 20, 2008

7

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satisfactory processing of said compositions. The proposed constitution leads to excellent mechanical properties even under wet or moist conditions, and unexpectedly high heat deflection temperatures are achieved, particularly when reinforcing fibers are also used.

The prior art does not particularly recommend the specific combination of 1,10-decanediamine and 1,6-hexanediamine, and there is certainly no indication in the prior art of the specific molar ratios which can provide the favorable properties presently found. Still less is known from the prior art about the low water absorption of a PA10T/6T combination, and nor is it known from the prior art that this PA10T/6T combination together with reinforcing fibers has high heat deflection temperatures above 260°C.

The present invention accordingly provides a polyamide molding composition with the following properties:

- high heat deflection temperature (melting point above 270°C or HDT A greater than 260°C for a PA reinforced with 50% of glass fibers)
- good processability (melting point below 320°C; crystallization behavior)
- low water absorption (< 5% after 240 h in water at 95°C)
- unaltered mechanical properties after water absorption (e.g. wet tensile modulus of elasticity > 100% of dry tensile modulus of elasticity, wet yield strength or wet breaking strength > 85% of dry yield strength or dry breaking strength)
- good surface quality of glass-fiber-reinforced products
- high dimensional stability.

March 20, 2008

8

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A first preferred embodiment is therefore one wherein the melting point and respectively the temperature of deflection to ISO-R 75, method A (DIN 53 461) of component (A) and/or of the entire polyamide molding composition is above 260°C or above 270°C, preferably in the range from 270 to 320°C, particularly preferably in the range from 270 to 310°C.

The ratios are moreover preferably adjusted in such a way that the water sbsorption of component (A) and/or of the entire polyamide molding composition is less than 5% by weight, preferably less than 4% by weight and in particular less than 3.5% by weight, e.g. after 240 h in water at 95°C.

It has moreover been found to be advantageous that the ratio of wet:dry tensile moduli of elasticity is greater than or equal to 0.95, preferably greater than or equal to 1.00, with particular preference greater than or equal to 1.05. It is likewise advantageous that the ratio of wet:dry maximum tensile strengths is greater than or equal to 0.85, preferably greater than 0.90, with particular preference greater than or equal to 0.95. The maximum tensile strength corresponds to the maximum strength in the tensile strain graph determined to ISO 527.

For adequately high molecular weight and high relative viscosity, together with good flowability and high MVR (melt volume flow rate), it has proven advantageous that the monomers used are adequately pure. In particular in the case of the diamine, it is advantageous to establish high purity, and it is therefore preferable that the melting point of the 1,10-decanediamine used is above 63°C and/or that its total diamine content is above 99%, and/or that its aminonitrile content is below 0.5 percent, and/or that

March 20, 2008

9

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its APHA (American Public Health Association color index) color is below 10 units.

As in particular can be discerned from the graphs given below, it has proven advantageous with regard to ideal adjustment of melting point and respectively with regard to water absorption that, within components (A), the (A1) fractions make up from 40 to 90 mol% and that the (A2) fractions make up from 10 to 60 mol%. Particular preference is given here to the following ratio: (A1) from 40 to 80 mol% and (A2) from 20 to 60 mol%, a particular ratio being the following: (A1) from 40 to 75 mol% and (A2) from 25 to 60 mol%.

As explained above, it is preferable that the 10T/6T copolyamide of component (A) is based in essence exclusively, preferably completely exclusively, on terephthalic acid as dicarboxylic acid, and/or that the 10T/6T copolyamide of component (A) is based in essence exclusively, preferably completely exclusively, on 1,10-decanediamine for (A1) and 1,6-hexanediamine for (A2) as diamine, and/or that component (A) is composed in essence exclusively, preferably completely exclusively, of the constituents (A1) and (A2).

According to another preferred embodiment, component (B) involves at least to some extent glass fibers and/or carbon fibers. Component (C) normally and generally involves additives and/or further polymers, for example selected from the following group: impact modifiers, adhesion promoters, crystallization accelerators or crystallization retarders, flow aids, lubricants, mold-release agents, plasticizers, stabilizers, processing aids, flame-retardant additions, pigments, dyes and markers, antistatic agents, nanoparticles in lamellar form, conductivity additives, such as carbon black, graphite powder, or carbon nanofibrils, residues from polymerization

processes, e.g. catalysts, salts and their derivatives, and regulators, such as monoacids or monoamines.

In another embodiment, the inventive molding composition also comprises moreover from 8 to 25% by weight, preferably from 10 to 22% by weight, and in particular from 10 to 18% by weight, of a flame retardant (as one constituent of component (C) or forming said component (C) in its entirety). The flame retardant is preferably halogen-free.

The flame retardant in component (C) or forming component (C) in its entirety preferably encompasses here from 60 to 100% by weight, with preference from 70 to 98% by weight, particularly from 80 to 96% by weight, of a phosphinic salt and/or diphosphinic salt (component (C1)) and from 0 to 40% by weight, preferably from 2 to 30% by weight, in particular from 4 to 20% by weight, of a nitrogen-containing synergist and/or of a nitrogen- and phosphorus-containing flame retardant (component (C2)).

Component (C2) preferably involves melamine or condensates of melamine, e.g. melem, melam, or melon, or reaction products of melamine with polyphosphoric acid, or involves reaction products of condensates of melamine with polyphosphoric acid, or involves a mixture thereof.

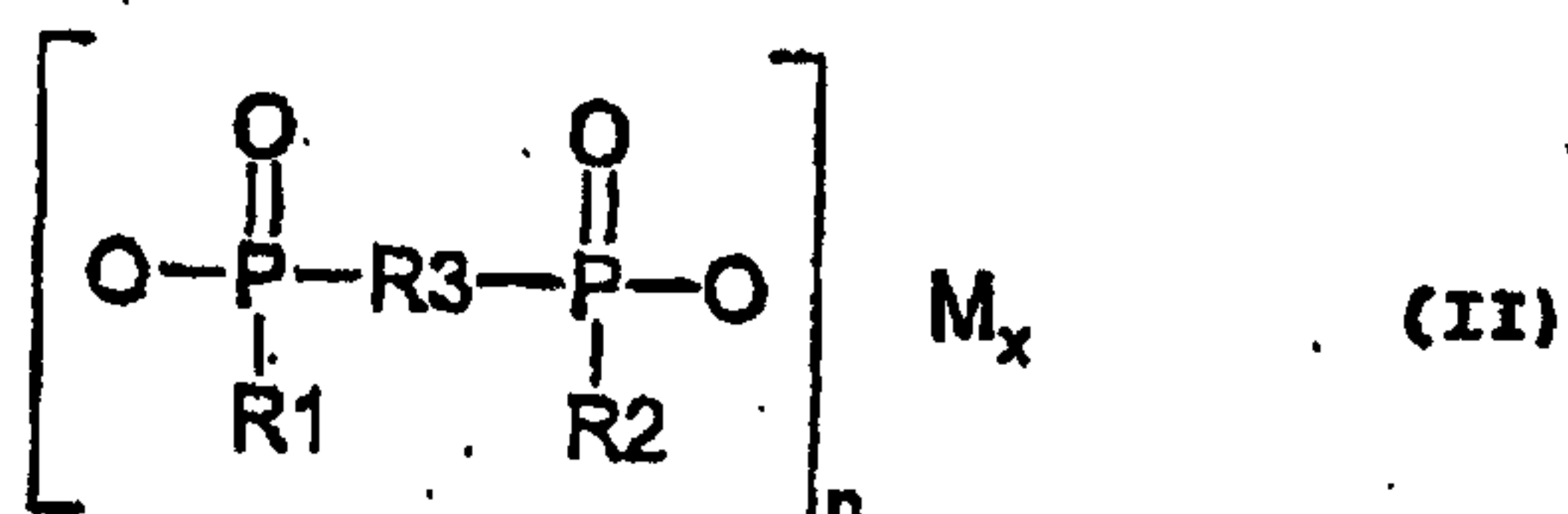
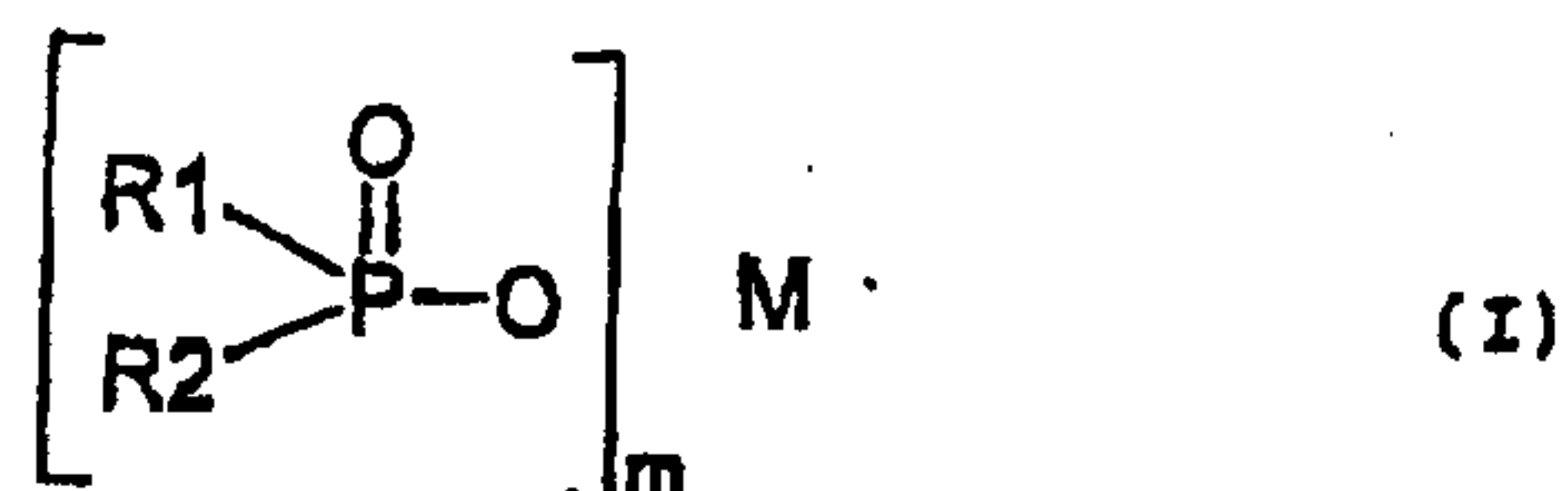
Melamine polyphosphate is particularly preferred as component (C2). These flame retardants are known from the prior art. Reference is made in this connection to DE 103 46 3261.

March 20, 2008

11

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A phosphinic salt of the general formula (I) and/or formula (II) and/or their polymers is preferred as component (C1)



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in which

- R1 and R2 are identical or different and are preferably C1-C8-alkyl, linear or branched, and/or aryl;
- 10 R3 is C1-C10-alkylene, linear or branched, or C6-C10-arylene or -alkylarylene, or arylalkylene;
- M is a metal ion from the 2nd or 3rd main or transition group of the Periodic Table of the Elements; and
- 15 m is 2 or 3;
- n is 1 or 3;
- x is 1 or 2.

- 20 The metal ion M used preferably comprises Al, Ca, and Zn.

- In combination with the flame-retardant components (C1) and (C2), it is also possible, if appropriate, to add
- 25 from 0.5 to 5% by weight, based on the entirety of (C1) and (C2), of oxygen-, nitrogen-, or sulfur-containing metal compounds, as stabilizers (component (C3)). Metals preferred here are aluminum, calcium, magnesium, and zinc. Suitable compounds are those selected from
- 30 the group of the oxides, hydroxides, carbonates,

March 20, 2008

12

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silicates, borates, phosphates, and stannates, and combinations and mixtures of said compounds, e.g. oxide hydroxides or oxide hydroxide carbonates. Examples are magnesium oxide, calcium oxide, aluminum oxide, zinc oxide, magnesium hydroxide, aluminum hydroxide, boehmite, dihydrotalcite, hydrocalumite, calcium hydroxide, tin oxide hydrate, zinc hydroxide, zinc borate, zinc sulfide, zinc phosphate, calcium carbonate, calcium phosphate, magnesium carbonate, basic zinc silicate, zinc stannate, calcium stearate, zinc stearate, magnesium stearate, potassium palmitate, magnesium behenate.

Another factor that should therefore be emphasized for the inventive polyamide molding compositions and respectively for the moldings produced therefrom is that excellent flame retardancy is achieved in combination with the exceptional properties described above. The UL classification of the molding composition, for a test specimen of thickness 0.8 mm, is V-0 (UL 94, test to standards from Underwriters Laboratories (U.L.), cf. www.ulstandards.com).

The invention further provides a short-fiber-reinforced pelletized material, a long-fiber-reinforced elongate pelletized material, or a semifinished product, or a molding, composed of a polyamide molding composition as described above, further details of which are also described at a later stage below, particularly preferably for use in a moist and/or wet environment.

The present invention also provides a process for the preparation of a polyamide molding composition as described above and further details of which are also described at a later stage below, where said process preferably comprises adding, to the monomer mixtures, during the preparation of component (A), at least one polycondensation catalyst, preferably in a proportion

March 20, 2008

13

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of from 0.005 to 1.5% by weight, where this can by way of example involve phosphorus compounds, such as phosphoric acid, phosphorous acid, hypophosphorous acid, phenylphosphonic acid, phenylphosphinic acid, and/or salts thereof with cations of valency from 1 to 3, e.g. Na, K, Mg, Ga, Zn, or Al, and/or their esters, such as triphenyl phosphate, triphenyl phosphite, or tris(nonylphenyl) phosphite, or a mixture thereof.

10 With regard to the dicarboxylic acids which, if appropriate, replace the terephthalic acid, the following applies: the inventive semiaromatic PA10T/6T copolyamides (A) contain this, as dicarboxylic acid, in a molar ratio which is in particular from 40 to 95/15 5 to 60, the material being in essence terephthalic acid. Some of the terephthalic acid can have been replaced by a subordinate amount, preferably not more than 30 mol% (based on the entire amount of the dicarboxylic acids) of other aromatic, aliphatic, or 20 cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms. Among the suitable aromatic dicarboxylic acids are naphthalenedicarboxylic acid (NDA) and isophthalic acid (IPS). Suitable aliphatic dicarboxylic acids are adipic acid, suberic acid, azelaic acid, 25 sebacic acid, undecanedioic acid, dodecanedioic acid, brassylic acid, tetradecanedioic acid, pentadecanedioic acid, hexadecanedioic acid, octadecanedioic acid, and dimer acid. Suitable cycloaliphatic dicarboxylic acids are cis- and/or trans-cyclohexane-1,4-dicarboxylic acid and/or cis- and/or trans-cyclohexane-1,3-dicarboxylic 30 acid (CHDA).

With regard to the diamines which, if appropriate, replace 1,6-hexanediamine and respectively 1,10- 35 decanediamine, the following applies: the inventive, semiaromatic PA10T/6T copolyamides (A) contain in essence a mixture composed of 1,6-hexanediamine and 1,10-decanediamine in a molar ratio of from 5/95 to

March 20, 2008

14

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60/40. It is also possible that a subordinate amount, which is preferably not more than 30 mol% (based on the entire amount of the diamines) of the diamines has been replaced by other diamines having from 4 to 36 carbon atoms. Examples of linear or branched, aliphatic diamines are 1,4-butanediamine, 1,5-pentanediamine, 2-methyl-1,5-pentanediamine (MPMD), 1,8-octanediamine (OMDA), 1,9-nonanediamine (NMDA), 2-methyl-1,8-octanediamine (MODA), 2,2,4-trimethylhexamethylenediamine (TMHMD), 2,4,4-trimethylhexamethylenediamine (TMHMD), 5-methyl-1,9-nonanediamine, 1,11-undecanediamine, 2-butyl-2-ethyl-1,5-pentanediamine, 1,12-dodecanediamine, 1,13-tridecanediamine, 1,14-tetradecanediamine, 1,16-hexadecanediamine, and 1,18-octadecanediamine. Examples of cycloaliphatic diamines that can be used are cyclohexanediamine, 1,3-bis(aminomethyl)cyclohexane (BAC), isophoronediamine, norbornanedimethylamine, 4,4'-diaminodicyclohexylmethane (PACM), 2,2-(4,4'-diaminodicyclohexyl)propane (PACP), and 3,3'-dimethyl-4,4'-diaminodicyclohexylmethane (MACM). m-Xylylenediamine (MXDA) may be mentioned as araliphaticdiamine.

With respect to the lactams and amino acids which can also be present, if appropriate, in component (A), the following applies: the inventive, semiaromatic PA10T/6T copolyamides (A) can contain not only 1,6-hexanediamine, 1,10-decanediamine, and terephthalic acid (taking into account the at least optional partial replacements discussed above for these constituents) but also a subordinate amount, which is preferably not more than 30 mol% (based on the entire amount of the monomers) of lactams or amino acids. Examples of suitable compounds are caprolactam (CL), α,ω -aminocaproic acid, α,ω -aminononanoic acid, α,ω -aminoundecanoic acid (AUA), laurolactam (LL), and ω -aminododecanoic acid (ADA).

March 20, 2008

15

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For higher glass transition temperatures, preference is given to additions of NDA, IPS, CHDA, MPMD, MODA, TMHMD, BAC, PACM, and MACM. NDA, BAC, and PACM are particularly preferred.

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For lower glass transition temperatures, preference is given to additions of long-chain monomers, such as dodecanedioic acid, brassylic acid, tetradecanedioic acid, pentadecanedioic acid, hexadecanedioic acid, octadecanedioic acid, dimer acid, 1,12-dodecanediamine, 1,13-tridecanediamine, 1,14-tetradecanediamine, 1,16-hexadecanediamine, and 1,18-octadecanediamine. Dodecanedioic acid and 1,12-dodecanediamine are particularly preferred.

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For adequately high molecular weight and high relative viscosity, together with good flowability and high MVR, the monomers used should preferably have adequate purity. In particular in the case of 1,10-decanediamine, it is advantageous that melting point is above 63°C, total diamine content is above 99%, aminonitrile content is below 0.5%, and APHA color is below 10 units.

Polycondensation catalysts that can be added to the monomer mixtures are from 0.005 to 1.5% by weight of phosphorus compounds, such as phosphoric acid, phosphorous acid, hypophosphorous acid, phenylphosphonic acid, phenylphosphinic acid, and/or salts thereof with cations of valency from 1 to 3, e.g. Na, K, Mg, Ga, Zn, or Al, and/or their esters, such as triphenyl phosphate, triphenyl phosphite, or tris(nonylphenyl) phosphite. Preference is given to hypophosphorous acid and sodium hydrogen hypophosphite monohydrate in an amount of from 100 to 500 ppm of phosphorus, based on the semiaromatic PA10T/6T copolyamide (A).

March 20, 2008

16

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Because diamine compounds are more volatile than dicarboxylic acids, diamine loss occurs during the preparation process. Diamine is lost during evaporation of the water, during discharge of the precondensate, and during the post-condensation in the melt or in the solid phase. To compensate the diamine loss, therefore, it is preferable that a diamine excess of from 1 to 8% by weight, based on the entirety of the diamines, is added to the monomer mixture. The diamine excess is also used to regulate the molecular weight and the distribution of the end groups. In the process used according to the examples, a diamine excess of smaller than 3% gives a carboxy end group excess of from 10 to 150 mmol/kg. A diamine excess of more than 3% produces an amino end group excess of from 10 to 150 mmol/kg.

Regulators in the form of monocarboxylic acids or of monoamines can be added to the mixture and/or to the precondensate (prior to post-condensation) in order to regulate the molar mass, the relative viscosity or respectively the flowability or the MVR. Aliphatic, cycloaliphatic, or aromatic monocarboxylic acids or monoamines suitable as regulators are acetic acid, propionic acid, butyric acid, valeric acid, caproic acid, lauric acid, stearic acid, 2-ethylhexanoic acid, cyclohexanoic acid, benzoic acid, butylamine, pentylamine, hexylamine, 2-ethylhexylamine, n-octylamine, n-dodecylamine, n-tetradecylamine, n-hexadecylamine, stearylamine, cyclohexylamine, 3-(cyclohexylamino)propylamine, methylcyclohexylamine, dimethylcyclohexylamine, benzylamine, 2-phenylethylamine, etc. The regulators can be used individually or in combination. It is also possible to use, as regulators, other monofunctional compounds which can react with an amino or acid group, e.g. anhydrides, isocyanates, acyl halides or esters. The usual amount used of the regulators is from 10 to 200 mmol per kg of polymer.

March 20, 2008

17

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- In order to obtain a mixture which is homogeneous and can be stirred even at an early stage, it is advantageous to admix water with the monomer mixture.
- 5 The amount of water can be from 5 to 50% by weight, based on the entire mixture. The water can be added together with the diamines in the form of aqueous solutions of the diamines, or together with the dicarboxylic acid in the form of an aqueous slurry, or
- 10 separately. The molecular weight and the bulk density of the precondensate can be controlled via the amount of water and the pressure set (at which the water is evaporated), and the residence time.
- 15 The molding compositions can moreover be modified using up to 70% by weight of fillers and reinforcing materials (glass fibers and/or carbon fibers (including graphite fibers)). Short fibers (e.g. chopped glass whose length is from 2 to 50 mm) or continuous-filament
- 20 fibers (rovings) can be used for reinforcement.

The glass fibers preferably used here have non-circular cross section and have a main cross-sectional axis: secondary cross-sectional axis dimensional ratio of

25 more than 2, preferably from 2 to 8, in particular from 2 to 5. These glass fibers are known as flat glass fibers and have an oval or elliptical cross section, or elliptical cross section with narrowed portion(s) (these being known as cocoon fibers), or have a

30 polygonal, rectangular, or almost rectangular cross section. The glass fibers themselves here can have been selected from the group of E glass fibers, A glass fibers, C glass fibers, D glass fibers, M glass fibers, S glass fibers, and/or R glass fibers, preference being

35 given here to E glass fibers. The glass fibers per se can also have been provided with an aminosilane coating or an epoxysilane coating, and this therefore applies to flat and also to round or angular fibers whose main

March 20, 2008

18

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cross-sectional axis: secondary cross-sectional axis
dimensional ratio is less than 2.

5 The inventive flat glass fibers with non-circular cross
section are preferably used in the form of short glass
fibers (chopped glass whose length is from 0.2 to
20 mm, preferably from 2 to 12 mm).

10 A further characterizing feature of the flat glass
fibers used is that the length of the main cross-
sectional axis is preferably in the range from 6 to
40 μm , in particular in the range from 15 to 30 μm , and
the length of the secondary cross-sectional axis is in
the range from 3 to 20 μm , in particular in the range
15 from 4 to 10 μm .

Mixtures of glass fibers with circular and non-circular
cross section can also be used for reinforcement of the
inventive molding compositions, and the proportion of
20 flat glass fibers as defined above here is preferably
predominant, i.e. amounts to more than 50% by weight of
the total weight of the fibers. Combinations of the
glass fibers (glass fibers whose cross section is
circular and/or non-circular) with carbon fibers and/or
25 with synthetic fibers, e.g. aramid fibers, and/or
basalt fibers, can also be used as reinforcement.

If reinforced molding compositions with good
flowability and good surface quality are desired, in
30 particular in combination with flame retardants, the
reinforcing fibers are then preferably mainly (i.e. by
way of example to an extent of more than 80% by weight
or indeed more than 90% by weight) composed of flat
glass fibers or indeed exclusively composed of flat
35 glass fibers.

The diameter of the glass fibers used according to the
invention as rovings (filler component B) is from 10 to

March 20, 2008

19

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20 μm , preferably from 12 to 18 μm , where the cross
section of the glass fibers can be round, oval,
elliptical, elliptical with narrowed portion(s),
polygonal, rectangular, or almost rectangular.
5 Particular preference is given to fibers known as flat
glass fibers whose ratio of cross-sectional axes is
from 2 to 5. E glass fibers are particularly used
according to the invention. However, it is also
possible to use any of the other types of glass fiber,
10 e.g. A, C, D, M, S, or R glass fibers, or any desired
mixture thereof, or a mixture with E glass fibers.

In the case of long-fiber-reinforced molding
compositions, higher toughness values, and properties
15 even more similar to those of metals, are obtained if,
instead of the usual continuous-filament glass fibers
whose diameter is from 15 to 19 μm , these fibers are
used with diameter of from 10 to 14 μm , in particular
with diameter of from 10 to 12 μm .

20

The inventive polyamide molding compositions can be
prepared via the known processes for the production of
long-fiber-reinforced elongate pelletized material, in
particular via pultrusion processes, in which the
25 continuous-filament fiber strand (roving) is completely
saturated with the polymer melt and then cooled and
chopped.

The long-fiber-reinforced elongate pelletized material
30 thus obtained, the pellet length of which is preferably
from 3 to 25 mm, in particular from 4 to 12 mm, can be
further processed using the usual processing methods
(e.g. injection molding, compression molding) to give
moldings, and particularly good properties of the
35 molding are achieved here, using non-aggressive
processing methods. Non-aggressive in this context
means especially substantial avoidance of excessive
fiber breakage and of the attendant marked reduction of

March 20, 2008

20

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fiber length. In the case of injection molding, this means that it is preferable to use screws with large diameter and low compression ratio, in particular smaller than 2, and generously dimensioned nozzle channels and feed channels. A complementary factor to which attention should be paid is that high cylinder temperatures rapidly melt the elongate pelletized material (contact heating) and that the fibers are not excessively comminuted through excessive exposure to shear. According to the invention when these measures are taken into account, moldings are obtained whose average fiber length is higher than that of comparable moldings produced from short-fiber-reinforced molding compositions. The result of this is an additional improvement in properties, in particular in the case of tensile modulus of elasticity, ultimate tensile strength, and notched impact resistance.

The diameter of the continuous-filament carbon fibers used during the pultrusion process is from 5 to 10 μm , preferably from 6 to 8 μm . The continuous-filament carbon fibers can be used alone or in combination with continuous-filament glass fibers (circular and/or non-circular cross section).

To accelerate fiber impregnation, the fibers can be pre-heated to temperatures up to 400°C with the aid of a suitable IR, contact, radiative, or hot-gas pre-heating system. Apparatuses using spreader surfaces within the impregnation chamber provide complete impregnation of the fibers with the polymer melt. Strands emerging from the impregnation unit can be molded via controlled roll systems, thus giving pelletized material with circular, elliptical, or rectangular cross section.

To improve binding to the matrix and to improve fiber handling, the fibers may have been coated with sizes of

March 20, 2008

21

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different chemical nature, these being known in the prior art for glass fibers and for carbon fibers.

The thermoplastic molding compositions can preferably
5 comprise, as further component, a particulate filler,
or a mixture composed of two or more different fillers,
also in combination with reinforcing materials. By way
of example, it is possible to use mineral particulate
fillers based on talc, on mica, on silicate, on quartz,
10 on titanium dioxide, on wollastonite, on kaolin, on
amorphous silicas, on magnesium carbonate, on magnesium
hydroxide, on chalk, on lime, on feldspar, on barium
sulfate, on solid glass beads, on hollow glass beads,
or on ground glass, or to use permanently magnetic or
15 respectively magnetizable metal compounds, and/or
alloys. The fillers can also have been surface-treated.

The molding compositions can comprise stabilizers,
processing aids, and impact modifiers, and further
20 additives.

In another embodiment, the inventive molding
composition comprises up to 45% by weight of one or
more impact modifiers (IM). An IM concentration in the
25 range from 5 to 30% by weight is preferred.

The impact modifier, which can be used as a constituent
of component C, can be a natural rubber, polybutadiene,
polyisoprene, polyisobutylene, a copolymer of butadiene
30 and/or isoprene with styrene or with styrene
derivatives and with other comonomers, a hydrogenated
copolymer, and/or a copolymer produced via grafting or
copolymerization with anhydrides, (meth)acrylic acid,
or an ester thereof. The impact modifier (C) can also
35 be a graft rubber with a crosslinked elastomeric core
which is composed of butadiene, of isoprene, or of
alkyl acrylates, and which has a graft shell composed
of polystyrene, or can be a non-polar or polar olefin

March 20, 2008

22

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homo- or copolymer, such as ethylene-propylene rubber, ethylene-propylene-diene rubber, or ethylene-octene rubber, or ethylene-vinyl acetate rubber, or a non-polar or polar olefin homo- or copolymer produced via
5 grafting or copolymerization with anhydrides, (meth)acrylic acid, or an ester thereof. The impact modifier (C) can also be a carboxylic-acid-functionalized copolymer, such as poly(ethene-co-(meth)acrylic acid) or poly(ethene-co-1-olefin-co-
10 (meth)acrylic acid), where the 1-olefin is an alkene or an unsaturated (meth)acrylic ester having more than 4 atoms, inclusive of those copolymers in which the acid groups have been neutralized to some extent with metal ions.

15

Preferred IMs based on styrene monomers (styrene and styrene derivatives) and on other vinylaromatic monomers are block copolymers composed of alkenylaromatic compounds and of a conjugated diene,
20 and hydrogenated block copolymers composed of an alkenylaromatic compound and of conjugated dienes, and combinations of these types of IM. The block copolymer contains at least one block derived from an alkenylaromatic compound (A) and at least one block
25 derived from a conjugated diene (B). In the case of the hydrogenated block copolymers, the proportion of aliphatically unsaturated carbon-carbon double bonds has been reduced via hydrogenation. Suitable block copolymers are two-, three-, four-, and polyblock
30 copolymers with linear structure. However, branched and star-shaped structures can likewise be used according to the invention. Branched block copolymers are obtained in a known manner, e.g. via graft reactions of polymeric "side branches" onto a main polymer chain.

35

Other alkenylaromatic monomers that can be used alongside styrene or in a mixture with styrene are vinylaromatic monomers having substitution on the

March 20, 2008

23

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aromatic ring and/or on the C=C double bond by C1-20-hydrocarbon radicals or by halogen atoms.

Examples of alkenylaromatic monomers are styrene, p-methylstyrene, α -methylstyrene, ethylstyrene, tert-butylstyrene, vinyltoluene, 1,2-diphenylethylene, 1,1-diphenylethylene, vinylxylenes, vinyltoluenes, vinylnaphthalenes, divinylbenzenes, bromostyrenes, and chlorostyrenes, and combinations thereof. Preference is given to styrene, p-methylstyrene, alpha-methylstyrene, and vinylnaphthalene.

It is preferable to use styrene, α -methylstyrene, p-methylstyrene, ethylstyrene, tert-butylstyrene, vinyltoluene, 1,2-diphenylethylene, 1,1-diphenylethylene, or a mixture of these. It is particularly preferable to use styrene. However, it is also possible to use alkenylnaphthalenes.

Examples of diene monomers that can be used are 1,3-butadiene, 2-methyl-1,3-butadiene, 2,3-dimethyl-1,3-butadiene, 1,3-pentadiene, 1,3-hexadiene, isoprene, chloroprene, and piperylene. Preference is given to 1,3-butadiene and isoprene, particularly 1,3-butadiene (hereinafter referred to by the abbreviated term butadiene).

The alkenylaromatic monomer used preferably comprises styrene, and the diene monomer used preferably comprises butadiene, and this means that preference is given to styrene-butadiene block copolymer. The block copolymers are generally prepared via anionic polymerization in a manner known per se.

Other further comonomers can also be used concomitantly, in addition to the styrene monomers and diene monomers. The proportion of the comonomers is preferably from 0 to 50% by weight, particularly

March 20, 2008

24

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preferably from 0 to 30% by weight, and in particular from 0 to 15% by weight, based on the total amount of the monomers used. Examples of suitable comonomers are acrylates, in particular C1-12-alkyl acrylates, such as
5 n-butyl acrylate or 2-ethylhexyl acrylate, and the corresponding methacrylates, in particular C1-12-alkyl methacrylates, such as methyl methacrylate (MMA). Other possible comonomers are (meth)acrylonitrile, glycidyl (meth)acrylate, vinyl methyl ether, diallyl and divinyl
10 ethers of dihydric alcohols, divinylbenzene, and vinyl acetate.

In addition to the conjugated diene, the hydrogenated block copolymers also contain, if appropriate,
15 fractions of lower hydrocarbons, e.g. ethylene, propylene, 1-butene, dicyclopentadiene, or non-conjugated dienes. The proportion of the non-reduced aliphatic unsaturated bonds which result from the block B is smaller than 50% in the hydrogenated block
20 copolymers, preferably smaller than 25%, in particular smaller than 10%. The aromatic fractions derived from block A are reduced to an extent of at most 25%. The hydrogenated block copolymers, styrene-(ethylene-butylene) two-block and styrene-(ethylene-butylene)-
25 styrene three-block copolymers are obtained via hydrogenation of styrene-butadiene copolymers and of styrene-butadiene-styrene copolymers.

The block copolymers are preferably composed of from 20
30 to 90% by weight of block A, in particular from 50 to 85% by weight of block A. The diene can be incorporated in 1,2-orientation or in 1,4-orientation into the block B.

35 The molar mass of the block copolymers is from 5000 to 500 000 g/mol, preferably from 20 000 to 300 000 g/mol, in particular from 40 000 to 200 000 g/mol.

March 20, 2008

25

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Suitable hydrogenated block copolymers are the commercially available products, such as KRATON® (Kraton Polymers) G1650, G1651 and G1652, and TUFTEC® (Asahi Chemicals) H1041, H1043, H1052, H1062, H1141, and H1272.

Examples of non-hydrogenated block copolymers are polystyrene-polybutadiene, polystyrene-poly(ethylene-propylene), polystyrene-polyisoprene, poly(α -methylstyrene)-polybutadiene, polystyrene-polybutadiene-polystyrene (SBS), polystyrene-poly(ethylene-propylene)-polystyrene, polystyrene-polyisoprene-polystyrene, and poly(α -methylstyrene)-polybutadiene-poly(α -methylstyrene), and combinations thereof.

Suitable non-hydrogenated block copolymers which are commercially available are various products with the trademarks SOLPRENE® (Phillips), KRATON® (Shell), VECTOR® (Dexco), and SEPTON® (Kuraray).

According to another preferred embodiment, the inventive molding compositions are those wherein component C comprises a polyolefin homopolymer or an ethylene- α -olefin copolymer, particularly preferably an EP elastomer and/or EPDM elastomer (ethylene-propylene rubber and respectively ethylene-propylene-diene rubber). By way of example, an elastomer can be involved which is based on an ethylene-C3-12- α -olefin copolymer with from 20 to 96% by weight, preferably from 25 to 85% by weight, of ethylene, where it is particularly preferable here that the C3-12- α -olefin involves an olefin selected from the group of propene, 1-butene, 1-pentene, 1-hexene, 1-octene, 1-decene, and/or 1-dodecene, and it is particularly preferable that component C involves ethylene-propylene rubber and/or LLDPE, and/or VLDPE.

March 20, 2008

26

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Alternatively or additionally (by way of example in a mixture), C can comprise a terpolymer based on ethylene-C3-12- α -olefin with an unconjugated diene, and it is preferable here that this contains from 25 to 85%
5 by weight of ethylene and up to at most amounts in the region of 10% by weight of an unconjugated diene, and it is particularly preferable here that the C3-12- α -olefin involves an olefin selected from the group of propene, 1-butene, 1-pentene, 1-hexene, 1-octene, 1-
10 decene, and/or 1-dodecene, and/or where the unconjugated diene has preferably been selected from the group of bicyclo[2.2.1]heptadiene, 1,4-hexadiene, dicyclopentadiene, and/or in particular 5-ethylidenenorbornene.

15

Ethylene-acrylate copolymers can also be used as constituent for component C.

Other possible forms of constituents for component C
20 are the ethylene-butylene copolymers and respectively mixtures (blends) which comprise these systems.

It is preferable that component C comprises constituents having anhydride groups, these being
25 introduced via thermal or free-radical reaction of the main-chain polymer with an unsaturated dicarboxylic anhydride, with an unsaturated dicarboxylic acid, or with a monoalkyl ester of an unsaturated dicarboxylic acid, at a concentration sufficient for good binding to
30 the polyamide, and it is preferable here to use reagents selected from the following group:

maleic acid, maleic anhydride, monobutyl maleate, fumaric acid, aconitic acid, and/or itaconic anhydride.
35 It is preferable that from 0.1 to 4.0% by weight of an unsaturated anhydride are grafted onto the impact-resistant component as a constituent of C, or that the unsaturated dicarboxylic anhydride or its precursor is

March 20, 2008

27

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applied by grafting together with another unsaturated monomer. It is generally preferable that the degree of grafting is in the range from 0.1 to 1.0%, particularly preferably in the range from 0.3 to 0.7%. Another possible constituent of component C is a mixture composed of an ethylene-propylene copolymer and of an ethylene-butylene copolymer, the degree of maleic anhydride grafting (degree of MA grafting) here being in the range from 0.3 to 0.7%.

The possible systems cited above for this component can also be used in mixtures.

Component C can moreover comprise components which have functional groups, e.g. carboxylic acid groups, ester groups, epoxy groups, oxazoline groups, carbodiimide groups, isocyanate groups, silanol groups, and carboxylate groups, or can comprise a combination of two or more of the functional groups mentioned. Monomers which bear said functional groups can be bonded via copolymerization or grafting to the elastomeric polyolefin.

The IMs based on the olefin polymers can moreover also have been modified via grafting with an unsaturated silane compound, e.g. vinyltrimethoxysilane, vinyltriethoxysilane, vinyltriacetosilane, methacryloxypropyltrimethoxysilane, or propenyltrimethoxysilane.

The elastomeric polyolefins are random, alternating, or segmented copolymers having linear, branched, or core-shell structure, and contain functional groups which can react with the end groups of the polyamides, thus giving adequate compatibility between polyamide and IM.

The inventive IMs therefore include homopolymers or copolymers of olefins, e.g. ethylene, propylene, 1-

March 20, 2008

28

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butene, or copolymers of olefins and of copolymerizable monomers, such as vinyl acetate, (meth)acrylic ester, and methylhexadiene.

- 5 Examples of crystalline olefin polymers are low-, medium-, and high-density polyethylenes, polypropylene, polybutadiene, poly-4-methylpentene, ethylene-propylene block copolymers or ethylene-propylene random copolymers, ethylene-methylhexadiene copolymers, 10 propylene-methylhexadiene copolymers, ethylene-propylene-butene copolymers, ethylene-propylene-hexene copolymers, ethylene-propylene-methylhexadiene copolymers, poly(ethylene-vinyl acetate) (EVA), poly(ethylene-ethyl acrylate) (EEA), ethylene-octene 15 copolymer, ethylene-butene copolymer, ethylene-hexene copolymer, ethylene-propylene-diene terpolymers, and combinations of the polymers mentioned.

- 20 Examples of commercially available impact modifiers which can be used for the purposes of the constituents of component C are:

- TAFMER MC201: g-MA (-0.6%) blend from 67% EP copolymer (20 mol% propylene) + 33% EB copolymer (15 mol% 1-butene)): Mitsui Chemicals, Japan.
- 25 TAFMER MH5010: g-MA (-0.6%) ethylene-butylene copolymer; Mitsui.
- TAFMER MH7010: g-MA (-0.7%) ethylene-butylene copolymer; Mitsui.
- 30 TAFMER MH7020: g-MA (-0.7%) EP copolymer; Mitsui.
- EXXELOR VA1801: g-MA (-0.7%) EP copolymer; Exxon Mobile Chemicals, US.
- EXXELOR VA1803: g-MA (0.5-0.9%) EP copolymer, amorphous, Exxon.
- 35 EXXELOR VA1810: g-MA (-0.5%) EP copolymer, Exxon.
- EXXELOR MDEX 94-1 l: g-MA (0.7%) EPDM, Exxon.
- FUSABOND MN493D: g-MA (-0.5%) ethylene-octene copolymer, DuPont, US.

March 20, 2008

29

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FUSABOND A EB560D: (g-MA) ethylene-n-butyl acrylate copolymer, DuPont.

ELVALOY, DuPont.

- 5 Preference is also given to an ionomer in which the polymer-bonded carboxy groups have been bonded to one another entirely or to some extent via metal ions.

10 Particular preference is given to maleic-anhydride-grafting-functionalized copolymers of butadiene with styrene, to non-polar or polar olefin homo- and copolymers produced via grafting with maleic anhydride, and to carboxylic-acid-functionalized copolymers, such as poly(ethene-co-(meth)acrylic acid) or poly(ethene-
15 co-1-olefin-co-(meth)acrylic acid), in which the acid groups have to some extent been neutralized with metal ions.

The inventive PA10T/6T polyamides can be mixed with
20 polyphenylene ethers (PPE). The polyphenylene ethers are known per se. They are prepared (cf. US patents 3661848, 3378505, 3306874, 3306875 and 3639656) by conventional processes via oxidative coupling, from phenols disubstituted by alkyl groups in the ortho
25 position. The preparation process usually uses catalyst based on heavy metals, such as copper, manganese, or cobalt, in combination with other substances, such as secondary amines, tertiary amines, halogens, or a combination thereof. Mixtures of polyamides with
30 polyphenylene ethers are also known per se, but not with the copolyamide component proposed. By way of example WO-A-2005/0170039, WO-A-2005/0170040, WO-A-2005/0170041, and WO-A-2005/0170042 disclose mixtures composed of polyamide and PPE.

35

Suitable polyphenylene ethers are poly(2,6-diethyl-1,4-phenylene) ether, poly(2-methyl-6-ethyl-1,4-phenylene) ether, poly(2-methyl-6-propyl-1,4-phenylene) ether,

March 20, 2008

30

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poly(2,6-dipropyl-1,4-phenylene) ether, poly(2-ethyl-6-propyl-1,4-phenylene) ether, or copolymers such as those which contain 2,3,6-trimethylphenol, and also polymer mixtures. Preference is given to poly(2,6-dimethyl-1,4-phenylene) ether optionally in combination with 2,3,6-trimethylphenol units. The polyphenylene ethers can be used in the form of homopolymers, copolymer, graft copolymers, block copolymer, or ionomers.

10

The intrinsic viscosity of suitable polyphenylene ethers is generally in the range from 0.1 to 0.6 dl/g, measured in CHCl_3 at 25°C. This corresponds to a molecular weight M_n (number average) of from 3000 to 40 000 and to a weight-average molecular weight value M_w of from 5000 to 80 000. It is possible to use a combination of a high-viscosity polyphenylene ether and a low-viscosity polyphenylene ether. The ratio of the two polyphenylene ethers of different viscosity depends on the viscosities and on the physical properties desired.

20

The blends of the inventive PA10T/6T can comprise from 10 to 45% by weight of polyphenylene ether and optionally up to 30% by weight, preferably up to 15% by weight, of impact modifier. For better compatibility, compatibilizers are used in the form of polyfunctional compounds which interact with the polyphenylene ether, the polyamide, or both. The interaction can be chemical (e.g. via grafting) and/or physical (e.g. via influence on the surface properties of the disperse phase).

30

The compatibilizers can be polyfunctional compounds which contain at least one carboxylic acid group, carboxylic anhydride group, ester group, amide group, or imide group. Mention may be made by way of example of maleic acid, maleic anhydride, fumaric acid, acrylic acid, methacrylic acid, methylmaleic acid, methylmaleic

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March 20, 2008

31

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anhydride, itaconic acid, itaconic anhydride, butenylsuccinic acid, butenylsuccinic anhydride, tetrahydrophthalic acid, tetrahydrophthalic anhydride, N-phenylmaleimide, citric acid, malic acid, and 2-hydroxynonadecane-1,2,3-tricarboxylic acid, the mono- or diesters of the acids mentioned with C1-C12 alcohols, such as methanol or ethanol, the mono- or diamides of the acids mentioned which, if appropriate, can have substitution on the nitrogen by alkyl or aryl radicals having up to 12 carbon atoms, and the salts with alkali metals or with alkaline earth metals, e.g. calcium and potassium. Particularly advantageous compounds are maleic acid, fumaric acid, maleic anhydride, and citric acid. An amount of from 0.05 to 2% by weight of the compatibilizers can be added directly during blend preparation, or the polyphenylene ether and/or the polyamide is functionalized in a separate step via the compatibilizers.

The invention further provides for the use of the inventive molding compositions for the production of thermoplastically processable molded items, and also the molded items obtainable from the inventive compositions.

Examples of these molded items include: casings and functional parts for pumps, gearboxes, valves and water meters, throttle valves, cylinders, pistons, headlamp casings, reflectors, bend-adaptive lighting, gearwheels, engine mountings and gearbox mountings, connectors, including plug connectors, profiles, foils, or layers of multilayer foils; they also include fibers, electronic components, casings for electronic components, tools, composite materials, fluid-conducting lines and containers, in particular in the automobile sector, smooth and corrugated mono- or multilayer tubes, tube sections, spigots, fittings for the connection of hoses, of corrugated tubes, and of

March 20, 2008

32

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lines conducting fluids, a constituent of multilayer lines (inner, outer, or intermediate layer), individual layers in multilayer containers, hydraulic lines, brake lines, clutch lines, coolant lines, brake-fluid
5 containers, etc.

The molded items can be produced by the processes of injection molding, extrusion, or blow molding.

10 The present invention further provides a powder based on the PA10T/6T copolyamides, a layer-by-layer process in which regions of the respective pulverulent layer are melted selectively, and are hardened after cooling, and also moldings produced from said powder.

15 It is preferable here to use powders whose average grain size is from 30 to 200 μm , in particular from 50 to 150 μm , an example being those obtained via grinding processes and precipitation processes. Preferred
20 processes here are particularly those which lead to particles whose shape is as close as possible to spherical, since these exhibit advantages during application of powder in layers in the selective laser sintering process (SLS process).

25 It is preferable to use unregulated or regulated copolyamide powders whose solution viscosity (0.5% by weight in m-cresol at 20°C) is in the range from 1.3 to 2.0, in particular in the range from 1.35 to 1.85.
30 Mono- and/or dicarboxylic acids, or mono- and/or diamines, are used for regulation. The ratio of carboxy to amino end groups in the regulated copolyamide powders is preferably greater than or equal to 1:2 and, respectively, 2:1, in particular greater than or equal
35 to 1:3 and, respectively, 3:1, where the concentration of the predominant carboxy or amino end groups is at least 50 mmol/kg, in particular at least 100 mmol/kg.

March 20, 2008

33

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One preferred embodiment of the sintering powder is a mixture of oppositely difunctionally regulated PA10T/6T. This means that the powders are composed of a combination of separately amine-regulated and carboxy-regulated powder particles. This mixed copolyamide powder retains its solution viscosity at an almost constant level on exposure to thermal stress below the melting point, for example the stress occurring during the SLS process for the non-sintered powder, and said mixed powder can therefore be used repeatedly in the rapid prototyping/rapid manufacturing process with only small amounts of virgin powder or indeed without addition of virgin powder. Disposal of powder residue often becomes unnecessary by virtue of these excellent recycling qualities.

One process which has particularly good suitability for the purposes of rapid prototyping or rapid manufacturing is laser sintering. In this process, plastics powders are selectively and briefly irradiated with a laser beam in a chamber, thus melting the powder particles impacted by the laser beam. The molten particles coalesce and, after cooling, solidify again to give a solid mass. This process can produce complex three-dimensional bodies simply and rapidly, via repeated irradiation of a succession of newly applied layers. However, there are a number of other suitable processes, as well as laser sintering. The selectivity of the layer-by-layer processes here can be achieved by way of application of susceptors, absorber, inhibitors, or masks, or by way of focused introduction of energy, for example via a laser beam or via a glass fiber cable.

Polyamide-12 powder has proven particularly successful in industry for laser sintering for the production of components. Although the parts manufactured from PA12 powder are often adequate for mechanical stresses and

March 20, 2008

34

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their properties are therefore close to those of the subsequent mass-produced injection-molded or extruded parts, PA12 has a low melting point of 178°C and low stiffness of about 1300 MPa, which is inadequate for many applications. These disadvantages can be overcome via the inventive copolyamide powders based on PA10T/6T whose melting point is in the range from 270 to 320°C and whose tensile modulus of elasticity is above 2500 MPa.

10

The sintering powder can comprise at least one further filler, as well as the 10T/6T copolyamide particles. These fillers can by way of example be glass particles or metal particles, or ceramic particles, or else the abovementioned particulate fillers. In particular, the sintering powder can comprise solid or hollow glass beads, steel shot, or granular metal as fillers. Glass beads whose average diameter is from 20 to 80 µm are typically used. In one preferred embodiment, these fillers have been coated with a thin layer of the inventive copolyamide, the layer thickness here preferably being from 2 to 30 µm, in particular from 5 to 20 µm. The average particle size of the filler particles here is preferably smaller than or approximately equal to that of the particles of the polyamides. The amount by which the average particle size of the fillers exceeds the average particle size of the polyamides should preferably be not more than 30%, preferably not more than 20%, and very particularly preferably not more than 10%. There is a particular limitation on particle size via the permissible layer thickness in the respective laser sintering apparatus.

35 The inventive copolyamide molding compositions can also be spun to give fibers which are resistant to temperature change and which have high strength and low water absorption. Together with other polymers, it is

possible to produce the fibers known as bicomponent fibers, of side-by-side type and of core-shell type.

BRIEF EXPLANATION OF THE FIGURES

5 The invention will be explained in more detail below using inventive examples in conjunction with the figures.

Fig. 1 shows the melting points of PA 10T/6T; and

Fig. 2 shows the water absorption of PA 10T/6T.

10

METHODS OF WORKING THE INVENTION

Production of the products/preparation processes:

15 The semiaromatic PA 10T/6T copolyamides (A) can be prepared by processes known per se. Suitable processes have been described in various publications, and some of the possible processes discussed in the patent literature will be cited below, with regard to the process for the preparation of the copolyamide of
20 component (A) of the present invention:

DE 195 13 940 describes a process which encompasses the following stages, and this process can be used for the preparation of component (A):

25

a) a salt-formation stage for the formation of salts composed of diamine(s) and dicarboxylic acid(s) in an aqueous solution of strength from 5 to 50% by weight comprising the components, and, if
30 appropriate, partial prereaction to give low-molecular-weight oligoamides at temperatures of from 120°C to 220°C and under pressures of up to 23 bar,

March 20, 2008

36

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- b) if appropriate, transfer of the solution from stage a) into a second reaction vessel or into a stirred autoclave, under the conditions prevailing at the end of its preparation process,
- 5
- c) conduct of the reaction phase during which the reaction takes place to give the precondensates, with heating of the reactor contents to a prescribed temperature and controlled adjustment of the partial water vapor pressure to the prescribed value, which is maintained via controlled discharge of water vapor or, if appropriate, controlled infeed of water vapor from a steam generator associated with the autoclave,
- 10
- 15
- d) a stationary-state phase to be maintained for at least 10 minutes, in which the temperature of the reactor contents and the partial water vapor pressure are respectively adjusted in a controlled manner - using the measures listed under c) in the case of the partial water vapor pressure - to the values intended for the transfer of the precondensates to the following stage of the process,
- 20
- 25
- the above with the proviso that in the case of precondensates of semicrystalline polyamides or copolyamides whose melting point is more than 280°C (melting point maximum measured by means of differential scanning calorimetry) the temperature of the reactor contents during this phase d) and phase c) is not permitted to exceed 265°C, and that, for said semicrystalline polyamides or copolyamides, during phases d) and c), the boundary conditions described are to be maintained with respect to the dependency of the minimum partial water vapor pressure to be used on the
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March 20, 2008

37

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temperature of the reactor contents and on the amide group concentration of the polymer,

- 5 e) a discharge phase, during which the precondensates can be introduced into a final reaction apparatus, while the temperature prevailing at the end of phase d) is kept constant, and the partial water vapor pressure prevailing at said juncture is at least maintained, via infeed of water vapor from
10 said steam generator into the autoclave, and all discharge lines/assemblies associated therewith, either in the molten state by way of a buffer device directly or by way of a separator apparatus and passage through the solid state, with
15 subsequent optional drying and/or comminution and, if appropriate, further stages of the process.

EP 0 976 774 describes a process for the preparation of polyamides which encompasses the following steps in the
20 stated sequence and which likewise can be used for the preparation of the copolyamide of component (A), if the corresponding constituents are replaced according to the invention:

- 25 (i) a step in which a dicarboxylic acid component with terephthalic acid content and a diamine component are polycondensed in the presence of from 15 to 35% by weight of water at a reaction temperature of from 250°C to 280°C and at a
30 reaction pressure (P) which complies with the following formula $P_0 \geq P \geq 0.7 P_0$, where P_0 is the saturated vapor pressure of water at the reaction temperature, in order to form a primary polycondensate;
- 35 (ii) a step in which the resultant polycondensate formed as in the preceding step (i) is taken from the reactor into an atmospheric

March 20, 2008

38

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environment while its temperature is in the range from 250°C to 280°C and its water content is in the range from 15 to 35% by weight;

- 5 (iii) a step in which the primary polycondensate thus taken from the preceding step (ii) is subjected to solid-phase polymerization or polymerization in the melt, in order to give a polyamide with an increased molecular weight.

10

EP 0 129 195, EP 0 129 196, and EP 0 299 444 describe processes for the continuous preparation of polyamides which are also suitable in appropriately modified form for the production of component (A), by first heating
15 aqueous solutions of strength from 30 to 70% of salts composed of dicarboxylic acids and of diamines under elevated pressure of from 1 to 10 bar, with simultaneous evaporation of water, within a residence time of less than 60 seconds, to a temperature of from
20 250 to 300°C, and then continuously separating prepolymers and vapors, rectifying the vapors, and returning the entrained diamines. Finally, the prepolymer is passed to a polycondensation zone and polycondensed at a gage pressure of from 1 to 10 bar
25 and at a temperature of from 250 to 300°C. On exit from the evaporator zone, the degree of conversion is advantageously at least 93% and the water content of the prepolymer is at most 7% by weight. Formation of diamines is substantially avoided by these short
30 residence times.

US 4,831,108 describes a polycondensation process for the preparation of polyamides, polyamideimides, polyesters, and polyarylates, which likewise can be
35 used in appropriately modified form for the preparation of component (A), and which is characterized in that a heated solution of a salt or of a prepolymer, or of a mixture composed of a salt and of a prepolymer, is

March 20, 2008

39

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first formed, and practically is homogeneous, and forms a single phase, and is stable at the selected polycondensation temperature, and readily atomizes, and then this solution is fed, with formation of an aerosol, into a vaporization reactor, which is operated at a pressure of from about 0 to 2.76 MPa (from 0 to 400 psig), for purposes of condensation and polymerization, where said vaporization reactor has been designed for high heat flux with wall temperatures of from about 204 to 538°C (from 400 to 1000°F) and melting points of from about 177 to 399°C (from 350 to 750°F), and where the resultant polymer is kept in the reactor for from about 0.1 to about 20 seconds.

US 4,607,073 reveals that semiaromatic polyamides can also be prepared from terephthaloyl chloride or dimethyl terephthalate with the corresponding diamines. Polyamide is prepared via precondensation of the dry salt at 310°C under nitrogen and at atmospheric pressure and then 12 hours of solid-phase postcondensation at 295°C. This type of process can also be used for preparation of component (A) after appropriate modification.

According to DE 14 95 393 and US 3,454,536, it is preferable, when preparing the polyamides from the dicarboxylic esters, to begin by heating the starting components in the presence of water to from 90°C to 100°C, and to remove the resultant methanol practically completely by distillation, and then to polycondense the distillation residue either at superatmospheric pressure with subsequent depressurization or at atmospheric pressure throughout, at temperatures of from 250 to 290°C. This type of process can also be used for the preparation of component (A).

The most familiar process for the preparation of polyamides with high melting points, and a suitable

March 20, 2008

40

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- process for the preparation of component (A), is the two-stage preparation first of a low-viscosity, low-molecular-weight precondensate, with subsequent post-condensation in the solid phase or in the melt (e.g. in an extruder). A three-stage process is also possible, composed of 1. precondensation, 2. solid-phase polymerization, and 3. polymerization in the melt, as cited in DE 696 30 260.
- For products with melting points below 300°C, another suitable process is the single-stage batch process described by way of example in US 3,843,611 and US 3,839,296, in which the mixture of the monomers or their salts is heated for from 1 to 16 hours to temperatures of from 250 to 320°C, and the pressure is reduced from a maximum to the lowest pressure of up to 1 mmHg, with evaporation of gaseous material, if appropriate with the aid of an inert gas.
- Specific examples will be given below, and compared with comparative examples (C) and discussed. Storage in water for determination of the appropriate parameters here took place at 95°C for a time of 240 hours.
- The measurements were conducted to the following standards and on the following test specimens.

Tensile modulus of elasticity:

- ISO 527 using a tensile test velocity of 50 mm/min (unreinforced variants) or a tensile test velocity of 5 mm/min (reinforced variants)

ISO tensile specimen, standard: ISO/CD 3167, A1 type, 170 × 20/10 × 4 mm, temperature 23°C

Transverse stiffness was determined on a BIAx test specimen (BIAx, published in Noss'Ovra Staff Magazine, December 2006, No. 12, volume 29, EMS-

March 20, 2008

41

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CHEMIE AG), which permits direction-dependent measurement of stiffness and strength.

5 Maximum tensile strength, ultimate tensile strength, and transverse strength:

ISO 527 using a tensile test velocity of 50 mm/min (unreinforced variants) or a tensile test velocity of 5 mm/min (reinforced variants)

10 ISO tensile specimen, standard: ISO/CD 3167, A1 type, 170 × 20/10 × 4 mm, temperature 23°C

15 Transverse strength (transverse ultimate tensile strength) was determined on a BIAx test specimen (BIAx, published in Noss'Ovra Staff Magazine, December 2006, No. 12, volume 29, EMS-CHEMIE AG), which permits direction-dependent measurement of stiffness and strength.

20 Thermal behavior:

Melting point, enthalpy of fusion, and glass transition temperature (T_g):

ISO standard 11357-11-2

25

Granulated material

30 Differential scanning calorimetry (DSC) was carried out using a heating rate of 20°C/min. The onset temperature is stated for the glass transition temperature (T_g).

Relative viscosity:

35 DIN EN ISO 307, in 0.5% strength by weight m-cresol solution, 20°C, granulated material

HDT A (1.8 MPa), HDT B (0.45 MPa), and HDT C (8 MPa):

ISO 75

March 20, 2008

42

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ISO impact specimen, 80 x 10 x 4

Tube tests:

- 5 Low-temperature impact, breaking stress,
 elongation at break:

VW TL 52435

- 10 The low-temperature impact test was carried out at
 -40°C using 500 g, and the longitudinal tensile
 test was carried out at 23°C and 50% humidity,
 using 100 mm/min, on 8 x 1 mm tubes.

- 15 Bursting pressure

DIN 73378

8 x 1 mm tube

- 20 **Inventive examples 1-7 (IE 1-IE 7) and comparative
 examples 1, 2, 7, and 8 (CE1, CE2, CE7, and CE8), PreC**

- 25 Diamine(s), terephthalic acid, catalyst, regulator, and
 water are placed in a 20 l autoclave and are heated to
 the product temperature within the heating time, kept
 at the prescribed pressure for the pressure phase time,
 and then discharged by way of a nozzle. The
 precondensate is dried for 24 hours at 120°C under a
 vacuum of 30 mbar.

30

**Inventive examples 1-7 (IE 1-IE 7) and comparative
examples 1-4, 7, and 8 (CE1-CE4, CE7, and CE8), PostC**

- 35 The precondensate from example PreC is postcondensed in
 a twin-screw extruder from Werner and Pfleiderer using
 a screw diameter of 25 mm with prescribed process
 parameters (barrel temperature, screw rotation rate,

March 20, 2008

43

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throughput). The melt is devolatilized in zone 10 by a stream of nitrogen.

The product is drawn off in the form of a strand from a
5 die with diameter 3 mm and pelletized. The pellets are dried for 24 hours at 120°C in a vacuum of 30 mbar.

Inventive examples 1-15 (IE 1-IE 15) and comparative examples 1-12 (CE1-CE12), IMTS

10

The postcondensate from inventive example PostC and from the comparative example PostC, or, respectively, the compounded material (IE 11-IE 15, and CE 9-CE 12) is injection-molded in an Arburg Allrounder 320-210-750
15 injection-molding machine, to give ISO tensile specimens, at defined cylinder temperatures for zones 1 to 4 and at a defined mold temperature.

	mol%	PA10T/6T 44.9/55.1	PA10T/6T 49.9/50.1	PA10T/6T 55.0/45.0	PA10T/6T 65.5/34.5
<i>Precondensate (PreC)</i>		IE1-PreC	IE2-PreC	IE3-PreC	IE4-PreC
1,6-Hexanediamine	g	1323	1599	1061	797
1,10-Decanediamine	g	1597	2359	1920	2246
Terephthalic acid	g	3363	4428	3302	3240
Hypophosphorous acid (50% strength)	g	8	11	8	8
Benzoic acid	g	32		32	32
Water	g	5175	3600	5175	5175
Heating time	min	68	55	65	78
Product temperature	°C	260	260	260	260
Pressure phase time	min	60	60	60	60
Pressure	bar	32	32	32	32
<i>Postcondensate (PostC)</i>		IE1-PostC	IE2-PostC	IE3-PostC	IE4-PostC
Cylinder temperature	°C	330	340	320	320
Screw rotation rate	rpm	150	150	150	150
Throughput	kg/h	4	5	4	4
Relative viscosity		1.598	2.162	1.553	1.576
COOH	µeq/g	163	182	164	165
NH ₂	µeq/g	28	49	37	43
Melting point	°C	307	295	294	279
Enthalpy of fusion	J/g	44	37	32	39
Glass transition temperature	°C	125	126	124	121

March 20, 2008

44

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<i>Injection-molded test specimens (IMTS)</i>		IE1-IMTS	IE2-IMTS	IE3-IMTS	IE4-IMTS
Cylinder temperatures, zone 1	°C	315	315	315	315
Cylinder temperatures, zone 2	°C	320	320	320	320
Cylinder temperatures, zone 3	°C	325	325	325	325
Cylinder temperatures, zone 4	°C	330	335	330	330
Mold temperature	°C	110	90	110	110
Water absorption	% by wt.	3.3	3.6	3.2	3.0
Tensile modulus of elasticity, dry	MPa	2800	2700	2550	2500
Tensile modulus of elasticity, water-saturated	MPa	3150	3000	3000	2850
Modulus ratio		1.13	1.11	1.18	1.14
Maximum tensile strength, dry	MPa	85	106	90	87
Maximum tensile strength, water-saturated	MPa	84	90	80	77
Strength ratio		0.99	0.85	0.89	0.89

Table 1: Starting weights, process conditions, and properties for inventive examples IE1-IE4
PreC, PostC, and IMTS

March 20, 2008

45

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	mol%	PA10T/6T 76.5/23.5	PA10T/6T 82.2/17.8	PA10T/6T 88.0/12.0
<i>Precondensate (PreC)</i>		IE5-PreC	IE6-PreC	IE7-PreC
1,6-Hexanediamine	g	533	536	266
1,10-Decanediamine	g	2572	3670	2901
Terephthalic acid	g	3178	4180	3115
Hypophosphorous acid (50% strength)	g	8	11	8
Benzoic acid	g	32		32
Water	g	5175	3600	5175
Heating time	min	70	52	67
Product temperature	°C	260	260	260
Pressure phase time	min	60	60	60
Pressure	bar	32	32	32
<i>Postcondensate (PostC)</i>		IE5-PostC	IE6-PostC	IE7-PostC
Cylinder temperature	°C	320	330	320
Screw rotation rate	rpm	150	150	150
Throughput	kg/h	4	5	4
Relative viscosity		1.637	2.148	-
COOH	µeq/g	214	50	111
NH ₂	µeq/g	51	47	43
Melting point	°C	291	295	307
Enthalpy of fusion	J/g	38	41	46
Glass transition temperature	°C	124	122	118
<i>Injection-molded test specimens (IMTS)</i>		IE5-IMTS	IE6-IMTS	IE7-IMTS
Cylinder temperatures, zone 1	°C	315	335	315
Cylinder temperatures, zone 2	°C	320	340	320
Cylinder temperatures, zone 3	°C	325	345	325
Cylinder temperatures, zone 4	°C	330	350	330
Mold temperature	°C	110	90	110
Water absorption	% by wt.	2.8	2.8	2.4
Tensile modulus of elasticity, dry	MPa	2600	2850	2700
Tensile modulus of elasticity, water- saturated	MPa	2950	3100	3000
Modulus ratio		1.13	1.09	1.11
Maximum tensile strength, dry	MPa	88	104	89
Maximum tensile strength, water-				

March 20, 2008

46

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saturated	MPa	79	97	81
Strength ratio		0.90	0.93	0.91

Table 2: Starting weights, process conditions, and properties for inventive examples IE5-IE7
PreC, PostC, and IMTS

	mol%	PA10T/6T 35.2/64.8	PA10T 100	PA6T/61 70/30	PA6T/66 55/45
<i>Precondensate (PreC)</i>		CE1-PreC	CE2-PreC		
1,6-Hexanediamine	g	1584			
1,10-Decanediamine	g	1275	3230		
Terephthalic acid	g	3424	3053		
Hypophosphorous acid (50% strength)	g	8	8		
Benzoic acid	g	32	32		
Water	g	5175	5175		
Heating time	min	67	50		
Product temperature	°C	260	260		
Pressure phase time	min	45	60		
Pressure	bar	32	32		
<i>Postcondensate (PostC)</i>		CE1-PostC	CE2-PostC	CE3-PostC	CE4-PostC
Cylinder temperature	°C	330	330	350	340
Screw rotation rate	rpm	150	150	150	150
Throughput	kg/h	4	4	7	7
Relative viscosity		1.428	1.842	1.556	1.729
COOH	µeq/g	367	-	186	129
NH ₂	µeq/g	20	42	69	85
Melting point	°C	320	314	320	310
Enthalpy of fusion	J/g	44	46	40	45
Glass transition temperature	°C	126	116	134	95
<i>Injection-molded test specimens (IMTS)</i>		CE1-IMTS	CE2-IMTS	CE3-IMTS	CE4-IMTS
Cylinder temperatures, zone 1	°C	325	330	325	315
Cylinder temperatures, zone 2	°C	330	335	330	320
Cylinder temperatures, zone 3	°C	335	340	335	325
Cylinder temperatures, zone 4	°C	340	355	340	330
Mold temperature	°C	110	110	130	130
Water absorption	% by wt.	3.2	2.1	5.0	6.5
Tensile modulus of elasticity, dry	MPa	3050	2700	3850	3500
Tensile modulus of elasticity, water-					

March 20, 2008

47

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saturated	MPa	3450	2950	4500	1050
Modulus ratio		1.13	1.09	1.17	0.30
Maximum tensile strength, dry	MPa	48	91	81	93
Maximum tensile strength, water-saturated	MPa	48	85	64	48
Strength ratio		1.00	0.93	0.79	0.52

Table 3: Starting weights, process conditions, and properties for comparative examples CE1-CE4 PreC, PostC, and IMTS

- 5 Comparative example CE3-PostC and, respectively, CE4-PostC used a PA6T/6I precondensate whose solution viscosity is $\eta_{rel} = 1.14$ and, respectively, a PA6T/66 precondensate whose solution viscosity is $\eta_{rel} = 1.17$.
- 10 As can be seen from the graph in Fig. 1 of the results cited above, ideal melting points are obtained for the inventively claimed ratios of 1,10-decanediamine and 1,6-hexanediamine, a minimum being observed in the range from 60 to 70 mol% of 10T.
- 15
- As can be seen from the further graph provided in Fig. 2 of the results cited above, water absorption is always substantially greater for the systems in the comparative examples than for the polyamide molding
- 20 compositions proposed in the invention. It can moreover be seen that a fall in water absorption can be observed for increasing 10T proportions. Both melting point and water absorption are parameters that have to be taken into account, and the result is therefore the
- 25 inventively claimed ideal ranges.

March 20, 2008

48

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	mol%	PA66	PA12	PA6T/610	PA6T/612
		100	100	66/34	67/33
<i>Precondensate (PreC)</i>				CE7-PreC	CE8-PreC
1,6-Hexanediamine	g			2400	2400
Terephthalic acid	g			2203	2171
Sebacic acid	g			1382	
Dodecanedioic acid	g				1482
Na Hypophosphite	g			6	6
Benzoic acid	g			13	13
Water	g			2600	2600
Heating time	min			54	55
Product temperature	°C			260	260
Pressure phase time	min			90	90
Pressure	bar			32	32
<i>Postcondensate (PostC)</i>		CE5-PostC	CE6-PostC	CE7-PostC	CE8-PostC
Cylinder temperature	°C			370	370
Screw rotation rate	rpm			150	150
Throughput	kg/h			4	4
Relative viscosity		1.94	2.19	1.149	1.156
COOH	µeq/g	104	5	50	40
NH ₂	µeq/g	55	39	85	76
Melting point	°C	261	178	312	314
Enthalpy of fusion	J/g	49	49	45	41
Glass transition temperature	°C	54	20	99	96
<i>Injection-molded test specimens (IMTS)</i>		CE5-IMTS	CE6-IMTS	CE7-IMTS	CE8-IMTS
Cylinder temperatures, zone 1	°C	265	315	325	325
Cylinder temperatures, zone 2	°C	270	320	330	330
Cylinder temperatures, zone 3	°C	275	325	335	335
Cylinder temperatures, zone 4	°C	280	330	340	340
Mold temperature	°C	80	115	120	120
Water absorption	% by wt.	7.6	2.3	5.2	4.5
Tensile modulus of elasticity, dry	MPa	3400	1500	3000	2900
Tensile modulus of elasticity, water-saturated	MPa	850	1000	2500	2500
Modulus ratio		0.25	0.67	0.83	0.86
Maximum tensile strength, dry	MPa	91	50	99	91
Maximum tensile					

March 20, 2008

49

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strength, water-saturated	MPa	49	47	62	62
Strength ratio		0.54	0.94	0.63	0.68

Table 4: Starting weights, process conditions, and properties for comparative examples CE5-CE8
PreC, PostC, and IMTS

- 5 Comparative examples CE5 and CE6 are based on the following commercially available, high-molecular-weight polyamide-12 ($\eta_{rel} = 2.19$, EMS-CHEMIE AG, Switzerland) and polyamide-6,6 ($\eta_{rel} = 1.94$, RADICI, Italy) polymers.
- 10 Comparative examples CE7 and CE8 show that although a combination of terephthalic acid with long-chain dicarboxylic acids can reduce water absorption, the modulus ratios and strength ratios are below those of the PA10T/6T copolyamides.

15

Inventive examples 8-10 (IE8-IE10), PreC

- Diamine(s), terephthalic acid, catalyst, regulator, and water are placed in a dissolver and heated to 180°C, and, after homogenization of the monomer mixture, discharged into a feed vessel. The salt solution is continuously heated to 258°C in two heat exchangers and kept at a pressure of 34 bar in a tubular reactor and then discharged by way of a nozzle. The precondensate is dried for 24 hours at 120°C under a vacuum of 30 mbar.

25

Inventive examples 8-10 (IE8-IE10), PostC

- 30 The precondensate is postcondensed as in inventive examples 1-7 under the conditions listed in table 5.

March 20, 2008

50

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	mol%	PA10T/6T	PA10T/6T	PA10T/6T
		49.9/50.1	71.0/29.0	82.2/17.8
<i>Precondensate (PreC)</i>		IE8-PreC	IE9-PreC	IE10-PreC
1,6-Hexanediamine	g	29575	16485	9910
1,10-Decanediamine	g	43630	59834	67816
Terephthalic acid	g	79567	76652	75045
Hypophosphorous acid (50% strength)	g	197	197	197
Benzoic acid	g	970	770	970
Water	g	66000	66000	66000
<i>Postcondensate (PostC)</i>		IE8-PostC	IE9-PostC	IE10- PostC
Cylinder temperature	°C	330	320	320
Screw rotation rate	rpm	150	200	200
Throughput	kg/h	4	4	4
Relative viscosity		1.77	1.81	1.68
COOH	µeq/g	34	46	34
NH ₂	µeq/g	133	155	141
Melting point	°C	301	282	294
Enthalpy of fusion	J/g	50	48	60
Glass transition temperature	°C	123	118	115

Table 5: Starting weights, process conditions, and properties for inventive examples IE8-IE10, PreC and PostC

5

Inventive examples 11-15 (IE11-IE15) and comparative examples 10 and 11 (CE10 and CE11)

The postcondensate from inventive examples IE8-IE10, PostC is compounded in a twin-screw extruder from Werner and Pfleiderer using a screw diameter of 25 mm with prescribed process parameters (barrel temperature, screw rotation rate, and throughput). The product is drawn off in the form of a strand from a die of 3 mm diameter, and pelletized. The pellets are dried for 24 hours at 120°C.

March 20, 2008

51

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	mol%	PA10T/6T 49.9/50.1	Grivory HTV-5H1
<i>Compounded material</i>		IE11	CE9
IE8, PostC	% by wt.	50.0	
Glass fibers	% by wt.	50.0	
Barrel temperature	°C	330	
Screw rotation rate	rpm	150	
Throughput	kg/h	8	
<i>Injection-molded test specimens (IMTS)</i>		IE11-IMTS	CE9-IMTS
Cylinder temperatures, zone 1	°C	325	325
Cylinder temperatures, zone 2	°C	330	330
Cylinder temperatures, zone 3	°C	335	335
Cylinder temperatures, zone 4	°C	340	340
Mold temperature	°C	120	120
Water absorption	% by wt.	1.60	2.31
Tensile modulus of elasticity, dry	MPa	15800	18500
Tensile modulus of elasticity, water-saturated	MPa	15800	18600
Modulus ratio		1.00	1.01
Maximum tensile strength, dry	MPa	219	263
Maximum tensile strength, water-saturated	MPa	192	221
Strength ratio		0.88	0.84
HDT A (1.8 MPa)	°C	274	>280
HDT C (8 MPa)	°C	219	221

Table 6: Constitution and properties of the glassfiber-reinforced compounded materials of inventive example IE11 and of comparative example CE9

5

Grivory HTV-5H1 is a 50%-glassfiber-reinforced PA6T/6I, 70/30 mol%, from EMS-CHEMIE AG, Switzerland.

March 20, 2008

52

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In inventive example 11 (IE11), glass fibers whose length is 4.5 mm and whose diameter is 10 μm were used (CS 7928 glass fiber, BAYER AG, Germany).

	mol%	PA10T/6T 49.9/50.1	PA10T/6T 82.2/17.8	PA6T/6I 70/30	PA10T 100
<i>Compounded material</i>		IE12	IE13	CE10	CE11
IE8, PostC	% by wt.	43.8			
IE10, PostC	% by wt.		43.8		
PA6T/6I 70/30 - PostC	% by wt.			43.8	
CE2, PostC	% by wt.				43.8
Glass fibers	% by wt.	35.0	35.0	35.0	35.0
Millicarb (CaCO_3)	% by wt.	20.0	20.0	20.0	20.0
Carbon black	% by wt.	1.2	1.2	1.2	1.2
masterbatch					
Barrel temperature	$^{\circ}\text{C}$	320	320	340	315
Screw rotation rate	rpm	150	150	150	150
Throughput	kg/h	10	10	10	10
<i>Injection-molded test specimens (IMTS)</i>		IE12-IMTS	IE13-IMTS	CE10-IMTS	CE11-IMTS
Cylinder temperatures, zone 1	$^{\circ}\text{C}$	315	315	335	315
Cylinder temperatures, zone 2	$^{\circ}\text{C}$	320	320	340	320
Cylinder temperatures, zone 3	$^{\circ}\text{C}$	325	325	345	325
Cylinder temperatures, zone 4	$^{\circ}\text{C}$	340	340	350	340
Mold temperature	$^{\circ}\text{C}$	150	150	150	150
Tensile modulus of elasticity, dry	MPa	14100	14500	16600	16300
Maximum tensile strength, dry	MPa	179	183	196	167
Elongation at break, dry	%	1.8	1.9	1.6	1.7
Surface quality	$^{\circ}\text{C}$	good	good	very good	poor
HDT A (1.8 MPa)	$^{\circ}\text{C}$	267	269	277	
HDT C (8 MPa)	$^{\circ}\text{C}$	180	207	163	

5 Table 7: Constitution and properties of the hybrid-reinforced compounded materials of examples IE12-IE13 and of the comparative examples CE10 and CE11.

10 When straight PA10T is used for the hybrid-reinforced compounded materials, processing by injection molding

March 20, 2008

53

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is very difficult, because material freezes in the injection-molding nozzle, because of the high crystallization rate. The surface quality of 10 x 10 cm plaques is poor because of the high crystallinity, whereas that of the PA10T/6T copolyamides is substantially better.

	mol%	PA10T/6T	PA10/6T	Grilamid
		71.0/29.0	82.2/17.8	XE 3835
<i>Compounded material</i>		IE14	IE15	CE12
IE9, PostC	% by wt.	77.5		
IE10, PostC	% by wt.		77.5	
Tafmer MH7020	% by wt.	22.5	22.5	
Barrel temperature	°C	300	320	
Screw rotation rate	rpm	200	200	
Throughput	kg/h	10	10	
<i>Injection-molded test specimens (IMTS)</i>		IE14-IMTS	IE15-IMTS	CE12-IMTS
Cylinder temperatures, zone 1	°C	315	315	265
Cylinder temperatures, zone 2	°C	320	320	270
Cylinder temperatures, zone 3	°C	325	325	275
Cylinder temperatures, zone 4	°C	330	330	280
Mold temperature	°C	150	150	80
Water absorption	% by wt.	3.0	2.9	1.4
Tensile modulus of elasticity, dry	MPa	1540	1480	1230
Tensile modulus of elasticity, water-saturated	MPa	1590	1540	700
Modulus ratio		1.03	1.04	0.57
Maximum tensile strength, dry	MPa	52	50	45
Maximum tensile strength, water-saturated		44	43	44
Strength ratio		0.85	0.86	0.98
HDT B (0.45 MPa)	°C	123	127	101
HDT A (1.8 MPa)	°C	107	106	52
<i>8 x 1 cm tubes</i>				
Rotation rate	rpm	38	38	64
Melt temperature	°C	308	310	258
Take-off speed	m/min	20	20	40
Low-temperature	%	no	10%	no

March 20, 2008

54

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impact, -40°C, 500 g	fracture	fracture	fracture	fracture
Bursting pressure, 23°C	bar	75	91	99
Bursting pressure, 130°C	bar	28	36	23
Breaking stress	MPa	42	45	32
Elongation at break	%	148	173	203

Table 8: Constitution and properties of the impact-modified compounded materials of inventive examples IE14-IE15 and of the comparative example CE12.

5

Grilamid XE 3835 is an impact-modified PA12 from EMS-CHEMIE AG, Switzerland.

10 Tubes of dimensions 8 × 1 mm were produced under the stated conditions from the products listed in table 8, using a BMA 60-24D Nokia Maillefer pipe extruder.

Examples using flat glass fibers, inventive examples IE16-IE18

15

<i>Compounded material</i>		IE16	IE17	IE18
PA10T/6T (85/15), PostC	% by wt.	37.7	37.7	47.7
Glass fiber with circular cross section (NEG Ec03T-292H)		60.0		
Flat glass fibers (NITTOBO CSG3PA-820)	% by wt.		60.0	50.0
Kaolin	% by wt.	0.16	0.16	0.16
KI/Ca stearate, 98/2	% by wt.	0.12	0.12	0.12
CuJ	% by wt.	0.02	0.02	0.02
Barrel temperature	°C	330	330	330
Screw rotation rate	rpm	150	150	150
Throughput	kg/h	8	8	8
<i>Injection molded test specimens</i>		IE16-IMTS	IE17-IMTS	IE18-IMTS
Cylinder temperatures, zone 1	°C	325	325	325
Cylinder temperatures, zone 2	°C	330	330	330
Cylinder temperatures, zone 3	°C	335	335	335
Cylinder temperatures, zone 4	°C	340	340	340

March 20, 2008

55

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Mold temperature	°C	120	120	120
Water absorption (240 h, 95°C)	% by wt.	1.12	0.96	1.50
Tensile modulus of elasticity, dry	MPa	20600	20700	16300
Tensile modulus of elasticity, water- saturated	MPa	20200	21300	17000
Modulus ratio		0.98	1.03	1.04
Maximum tensile strength, dry	MPa	225	240	241
Maximum tensile strength, water- saturated	MPa	184	213	223
Strength ratio		0.82	0.89	0.93
HDT A (1.8 MPa)	°C	267	>280	274
HDT C (8 MPa)	°C	204	236	222
*) Longitudinal tensile modulus of elasticity	MPa	20600	19800	16200
*) Transverse tensile modulus of elasticity	MPa	9000	11200	9400
Ratio of transverse tensile modulus of elasticity to longitudinal tensile modulus of elasticity	MPa	0.44	0.57	0.58
*) Longitudinal ultimate tensile strength	MPa	226	229	230
*) Transverse ultimate tensile strength	MPa	77	115	115
Ratio of transverse and longitudinal ultimate tensile strengths		0.34	0.50	0.50

Table 9: Constitution and properties of the compounded materials reinforced with flat glass fibers.

(*) Mechanical properties were determined longitudinally and transversally with respect to the direction of injection molding with aid of the BIAx tensile specimen.

Flat glass fibers: NITTOBO CSG3PA-820, 3 mm long, 28 µm wide, 7 µm thick,
aspect ratio of cross-sectional axes = 4,

March 20, 2008

56

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aminosilane size, NITTO BOSEKI,
Japan (flat glass fibers for the
purposes of the description above)

5 Inventive examples IE16 to IE18 are based on a
postcondensate of the copolyamide PA10T/6T with a molar
ratio of 85:15, which was prepared by analogy with the
preceding inventive examples from the corresponding
precondensate.

10

The compounded materials reinforced with flat glass
fibers in particular have relatively high transverse
stiffness and transverse strength, and also a
relatively high HDT C value, in comparison with the
15 conventionally reinforced compounded materials, i.e.
those reinforced with glass fibers whose cross section
is circular.

March 20, 2008

57

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Examples of flame-retardant molding compositions,
inventive examples IE19-IE21 and comparative examples
CE13 and CE14:

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Compounded material		IE19	IE20	IE21	CE13	CE14
PA10T/6T (85/15), PostC	% by wt.	83.7	66.7	56.7	83.7	83.7
PA8T/6T (75:25), PostC	% by wt.					
PA12T, PostC	% by wt.					
Alugel 34-TH (Al tristearate)	% by wt.	0.3	0.3	0.3	0.3	0.3
Exolit GP1230	% by wt.	15.0	12.0	12.0	15.0	15.0
Melapur 200/70	% by wt.	0.5	0.5	0.5	0.5	0.5
Irganox 1098	% by wt.	0.5	0.5	0.5	0.5	0.5
Glass fiber (Vetrotex 995 EC10-4.5)	% by wt.		20.0	30.0		
Barrel temperature	°C	330	330	330	330	330
Screw rotation rate	rpm	150	150	150	150	150
Throughput	kg/h	8	8	8	8	8
Injection-molded test specimens		IE19- IMTS	IE20- IMTS	IE21- IMTS	CE13- IMTS	CE14- IMTS
Cylinder temperatures, zone 1	°C	325	325	325	325	325
Cylinder temperatures, zone 2	°C	330	330	330	330	330
Cylinder temperatures, zone 3	°C	335	335	335	335	335
Cylinder temperatures, zone 4	°C	340	340	340	340	340
Mold temperature	°C	120	120	120	120	120
Water absorption (240 h, 95°C)		2.1	1.6	1.4	2.9	1.9
Tensile modulus of elasticity, dry	MPa	3800	8100	10300	3800	3700
Ultimate tensile strength, dry	MPa	78	142	154	40	71
Elongation at break, dry	%	5.4	3.3	2.9	1.3	4.8
UL94 fire classification (specimen thickness: 0.8 mm)		V-0	V-0	V-0	V-2	V-2

Table 10: Constitution and properties of the compounded
materials equipped with halogen-free flame-
retardant system.

March 20, 2008

58

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Melapur® 200/70: a melamine polyphosphate (Ciba Spez. GmbH), flame retardant CAS No. 218768-84-4

5 Exolit® GP1230: an organophosphorus salt (Clariant Produkte GmbH), flame retardant.

10 The examples IE19 to IE21 are based on a postcondensate of the copolyamide PA10T/6T with a molar ratio of 85:15, prepared by analogy with the preceding inventive examples from the corresponding precondensate.

15 The halogen-free flame-retardant molding compositions of inventive examples 19 to 21 are reliably V-0, with and without glassfiber reinforcement, whereas the molding compositions of CE13 and CE14 achieve merely the UL classification V-2, despite identical flame-retardant modification.

WHAT IS CLAIMED IS:

1. A polyamide molding composition with the following constitution:

5

(A) from 30 to 100% by weight of at least one copolyamide 10T/6T, wherein this is composed of (A1) from 40 to 95 mol% of 10T units, formed from the monomers 1,10-decanediamine and terephthalic acid

10

(A2) from 5 to 60 mol% of 6T units, formed from the monomers 1,6-hexanediamine and terephthalic acid

15

(B) from 0 to 70% by weight of reinforcing materials and/or fillers

(C) from 0 to 50% by weight of additives and/or further polymers

where the entirety of components A to C is 100%,

20

with the proviso that in component (A), independently of one another, in (A1), (A2), or (A1) and (A2) up to 30 mol%, based on the entirety of the dicarboxylic acids, of the terephthalic acid can have been replaced by other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms,

25

and with the proviso that in component (A), independently of one another, in (A1), (A2), or (A1) and (A2) up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, can have been replaced by other diamines having from 4 to 36 carbon atoms,

30

35

and with the proviso that not more than 30 mol% in component (A), based on the entirety of the monomers, can have been formed via lactams or amino acids,

5

and with the proviso that the concentration of the entirety of the monomers which replace the terephthalic acid, 1,6-hexanediamine, and 1,10-decanediamine does not exceed 30 mol%, based on the entirety of the monomers used in component A.

10

2. The polyamide molding composition as claimed in claim 1, wherein the melting point and respectively the temperature of deflection to ISO-R 75, method A (DIN 53 461) of component (A), the entire polyamide molding composition, or combinations thereof is above 260°C.

15

3. The polyamide molding composition as claimed in claim 2, wherein said melting point and said temperature of deflection is above 270°C.

20

4. The polyamide molding composition as claimed in claim 2, wherein said melting point and said temperature of deflection is in the range of from 270 to 320°C.

25

5. The polyamide molding composition as claimed in claim 2, wherein said melting point and said temperature of deflection is in the range of from 270 to 310°C.

30

6. The polyamide molding composition as claimed in any one of claims 1 - 5, wherein the water absorption of component (A), or the entire polyamide molding composition, or of said component (A) and said

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entire polyamide molding composition is less than 5% by weight after 240 h in water at 95°C.

- 5 7. The polyamide molding composition as claimed in claim 6, wherein said water absorption is less than 4% by weight after 240 h in water at 95°C.
- 10 8. The polyamide molding composition as claimed in any one of claims 1 - 7, wherein the ratio of wet:dry tensile moduli of elasticity is greater than or equal to 0.95.
- 15 9. The polyamide molding composition as claimed in claim 8, wherein the ratio of wet:dry tensile moduli of elasticity is greater than or equal to 1.00.
- 20 10. The polyamide molding composition according to any one of claims 1 - 9, wherein the ratio of wet:dry maximum tensile strengths is greater than or equal to 0.85.
- 25 11. The polyamide molding composition according to claim 10, wherein the ratio of wet:dry maximum tensile strengths is greater than or equal to 0.90.
- 30 12. The polyamide molding composition as claimed in any one of claims 1 - 11, wherein, within component (A), the (A1) fractions make up from 40 to 90 mol% and the (A2) fractions make up from 10 to 60 mol%.
- 35 13. The polyamide molding composition as claimed in claim 12, wherein said (A1) fractions make up from 40 to 80 mol% and said (A2) fractions make up from 20 to 60 mol%.

14. The polyamide molding composition as claimed in claim 12, wherein said (A1) fractions make up from 40 to 75 mol% and said (A2) fractions make up from 25 to 60 mol%.
- 5
15. The polyamide molding composition according to any one of claims 1 - 14, wherein the 10T/6T copolyamide of component (A) is based exclusively on terephthalic acid as dicarboxylic acid.
- 10
16. The polyamide molding composition as claimed in any one of claims 1 - 14, wherein the other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms, which to some extent replace the terephthalic acid, have been selected from the group consisting of: naphthalenedicarboxylic acid (NDA), isophthalic acid (IPS), adipic acid, suberic acid, azaleic acid, sebacic acid, undecanedioic acid, dodecanedioic acid, brassylic acid, tetradecanedioic acid, pentadecanedioic acid, hexadecanedioic acid, octadecanedioic acid, dimer acid, cis- and/or trans-cyclohexane-1,4-dicarboxylic acid, cis- and/or trans-cyclohexane-1,3-dicarboxylic acid (CHDA), and combinations thereof.
- 15
- 20
- 25
17. The polyamide molding composition as claimed in claim 16, wherein, for a higher glass transition temperature, the other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms, which to some extent replace the terephthalic acid, have been selected from the group consisting of: naphthalenedicarboxylic acid (NDA), isophthalic acid (IPS), trans-cyclohexane-1,3-dicarboxylic acid (CHDA) or combinations thereof.
- 30
- 35

18. The polyamide molding composition as claimed in claim 16, wherein, for a lower glass transition temperature the other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids having from 6 to 36 carbon atoms, which to some extent replace the terephthalic acid, have been selected from the group consisting of: dodecanedioic acid, brassylic acid, tetradecanedioic acid, pentadecanedioic acid, hexadecanedioic acid, octadecanedioic acid, dimer acid, and combinations thereof.
19. The polyamide molding composition as claimed in claim 17, wherein said other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids is selected to be naphthalene dicarboxylic acid (NDA).
20. The polyamide molding composition as claimed in claim 18, wherein said other aromatic, aliphatic, or cycloaliphatic dicarboxylic acids is selected to be dodecanedioic acid.
21. The polyamide molding composition as claimed in any one of claims 1 - 20, wherein the 10T/6T copolyamide of component (A) is based exclusively on 1,10-decanediamine for (A1) and 1,6-hexanediamine for (A2), as diamine.
22. The polyamide molding composition as claimed in any one of claims 1 to 20, wherein the other diamines having from 4 to 36 carbon atoms which in component (A), independently of one another, in (A1), (A2), or (A1) and (A2) replace up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, have been selected from the group consisting of: linear or

branched aliphatic diamines,
cycloaliphaticdiamines, araliphatic diamines, and
combinations thereof.

- 5 23. The polyamide molding composition as claimed in claim
22, wherein the linear or branched aliphatic diamines
are selected from the group consisting of: 1,4-
butanediamine, 1,5-pentanediamine, 2-methyl-1,5-
10 pentanediamine (MPMD), 1,8-octanediamine (OMDA), 1,9-
nonanediamine (NMDA), 2-methyl-1,8-octanediamine
(MODA), 2,2,4-trimethylhexamethylenediamine (TMHMD),
2,4,4-trimethylhexamethylenediamine (TMHMD), 5-
methyl-1,9-nonanediamine, 1,11-tridecanediamine, 2-
15 butyl-2-ethyl-1,5-pentanediamine, 1,12-
dodecanediamine, 1,13-tridecanediamine, 1,14-
tetradecanediamine, 1,16-hexadecanediamine, 1,18-
octadecanediamine, and combinations thereof.
- 20 24. The polyamide molding composition as claimed in claim
22, wherein the cycloaliphaticdiamines are selected
from the group consisting of: cyclohexanediamine,
1,3-bis(aminomethyl)cyclohexane (BAC), isophorone-
diamine, norbornanedimethylamine, 4,4'-diamino-
25 dicyclohexylmethane (PACM), 2,2-(4,4'-diamino-
dicyclohexyl)propane (PACP), and 3,3'-dimethyl-4,4'-
diaminodicyclohexylmethane (MACM), and combinations
thereof.
- 30 25. The polyamide molding composition as claimed in claim
22, wherein the araliphatic diamines are selected to
be m-xylylenediamine (MXDA).
- 35 26. The polyamide molding composition as claimed in any
one of claims 22 - 25, wherein, for a higher glass
transition temperature, the other diamines having
from 4 to 36 carbon atoms which in component (A),

independently of one another, in (A1), (A2), or (A1) and (A2) replace up to 30 mol% of 1,10-decanediamine and respectively 1,6-hexanediamine, based on the entirety of the diamines, have been selected from the group consisting of: 2-methyl-1,5-pentanediamine (MPMD), 2-methyl-1,8-octanediamine (MODA), 2,2,4-trimethylhexamethylenediamine (TMHMD), 1,3-bis(aminomethyl)cyclohexane (BAC), 4,4'-diaminodicyclohexylmethane (PACM), 3,3'-dimethyl-4,4'-diaminodicyclohexylmethane (MACM), and combinations thereof.

27. The polyamide molding composition as claimed in any one of claims 22 - 25, wherein, for a lower glass transition temperature, said other diamines have been selected from the group consisting of: 1,12-dodecanediamine, 1,13-tridecanediamine, 1,14-tetradecanediamine, 1,16-hexadecanediamine, 1,18-octadecanediamine, and combinations thereof.

28. The polyamide molding composition as claimed in claim 26, wherein, said other diamines have been selected from the group consisting of: 1,3-bis(aminomethyl)cyclohexane (BAC) and/or 4,4'-diaminodicyclohexylmethane (PACM), and combinations thereof.

29. The polyamide molding composition as claimed in claim 27, wherein said other diamines are selected to be 1,12-dodecanediamine.

30. The polyamide molding composition as claimed in any one of claims 1 - 29, wherein component (A) is exclusively composed of the constituents (A1) and (A2).

31. The polyamide molding composition as claimed in any one of claims 1 to 30, wherein the lactams or amino acids have been selected from the group consisting of: caprolactam (CL), α,ω -aminocaproic acid, α,ω -aminononanoic acid, α,ω -aminoundecanoic acid (AUA), lauro lactam (LL), ω -aminododecanoic acid (ADA), and combinations of these.
32. The polyamide molding composition as claimed in any one of claims 1 - 31, wherein component (B) is at least to some extent comprised of: glass fibers, carbon fibers, or combinations thereof.
33. The polyamide molding composition as claimed in claim 32, wherein the glass fibers, carbon fibers, or mixtures thereof comprise short fibers.
34. The polyamide molding composition as claimed in claim 33, wherein the short fibers comprise chopped glass whose length is from 2 to 50 mm.
35. The polyamide molding composition as claimed in claim 32, wherein the glass fibers, carbon fibers, or mixtures thereof comprise continuous filament fibers.
36. The polyamide molding composition as claimed in claim 32, wherein the glass fibers, carbon fibers, or mixtures thereof comprise fibers which have a non-circular cross section and which have a main cross-sectional axis: secondary cross-sectional axis dimensional ratio of more than 2.
37. The polyamide molding composition as claimed in claim 36, wherein the main cross-sectional axis: secondary

cross-sectional axis dimensional ratio is in the range of from 2 to 8.

- 5 38. The polyamide molding composition as claimed in claim 36, wherein the main cross-sectional axis: secondary cross-sectional axis dimensional ratio is in the range of from 2 to 5.
- 10 39. The polyamide molding composition as claimed in any one of claims 32 - 38, wherein component (B) involves short fibers, continuous-filament fibers, or mixtures thereof in the form of glass fibers.
- 15 40. The polyamide molding composition as claimed in claim 39, wherein the glass fibers have a diameter of from 10 to 20 μm .
- 20 41. The polyamide molding composition as claimed in claim 40, wherein the glass fibers have a diameter of from 12 to 18 μm .
- 25 42. The polyamide molding composition as claimed in any one of claims 38 - 40, wherein the cross section of the glass fibers is round, oval, or angular.
- 30 43. The polyamide molding composition as claimed in any one of claims 39 - 42, which involves short fibers, continuous-filament glass fibers whose diameter is from 10 to 14 μm , or mixtures thereof.
- 35 44. The polyamide molding composition as claimed in claim 43, which involves short fibers, continuous-filament glass fibers whose diameter is from 10 to 12 μm , or mixtures thereof.

45. The polyamide molding composition as claimed in any one of claims 1 - 44, wherein component (C) involves additives and/or further polymers selected from the group consisting of: impact modifiers, adhesion promoters or compatibilizers, crystallization accelerators or crystallization retarders, flow aids, lubricants, mold-release agents, pigments, dyes and markers, plasticizers, stabilizers, processing aids, flame-retardant additions, antistatic agents, nanoparticles in lamellar form, conductivity additives, residues from polymerization processes, and regulators.
46. The polyamide molding composition as claimed in claim 45, wherein the flame-retardant additions are halogen-free flame-retardant additions.
47. The polyamide molding composition as claimed in claim 45, wherein the conductivity additives are selected from the group consisting of: carbon black, graphite powder, carbon nanofibrils, and combinations thereof.
48. The polyamide molding composition as claimed in claim 45, wherein the residues from polymerization processes are selected from the group consisting of: catalysts, salts, their derivatives, and combinations thereof.
49. The polyamide molding composition as claimed in claim 45, wherein the regulators are selected from the group consisting of: monoacids, monoamines, and combinations thereof.
50. The polyamide molding composition as claimed in any one of claims 1 - 49, wherein the concentration of

the entirety of the monomers which replace terephthalic acid, 1,6-hexanediamine, and 1,10-decanediamine does not exceed 20 mol% based on the entirety of the monomers used in component A.

5

51. The polyamide molding composition as claimed in claim 50, wherein the concentration of the entirety of the monomers which replace terephthalic acid, 1,6-hexanediamine, and 1,10-decanediamine does not exceed 10 mol% based on the entirety of the monomers used in component A.

10

52. A polyamide mixture comprising a polyamide molding composition as claimed in any one of claims 1 - 51.

15

53. A polyamide mixture comprising a polyamide molding composition as claimed in any one of claims 1 - 51 and polyphenylene ether.

54. The polyamide mixture as claimed in claim 53, wherein the polyphenylene ether is in the form of homopolymers, of copolymer, of graft copolymers, of block copolymer, or of ionomers.

20

55. The polyamide mixture as claimed in claim 54, wherein the polyphenylene ether is selected from the group consisting of: poly(2,6-diethyl-1,4-phenylene) ether, poly(2-methyl-6-ethyl-1,4-phenylene) ether, poly(2-methyl-6-propyl-1,4-phenylene) ether, poly(2,6-dipropyl-1,4-phenylene) ether, poly(2-ethyl-6-propyl-1,4-phenylene) ether, copolymers, and mixtures thereof.

30

56. The polyamide mixture as claimed in claim 55, wherein the copolymer contains 2,3,6-trimethylphenol.

35

57. The polyamide mixture as claimed in any one of claims 53-56, wherein the mixture comprises from 10 to 45% by weight of polyphenylene ether.
- 5
58. The polyamide mixture as claimed in any one of claims 53-57, wherein the mixture further comprises up to 30% by weight of impact modifier.
- 10 59. The polyamide mixture as claimed in claim 58, wherein the mixture further comprises up to 15% by weight of impact modifier.
- 15 60. A pelletized material composed of a polyamide molding composition as claimed in any one of claims 1 to 51, or composed of a polyamide mixture as claimed in any one of claims 52 to 59.
- 20 61. The pelletized material as claimed in claim 60, wherein the pelletized material is a long-fiber-reinforced elongate pelletized material, a semifinished product, or a molding.
- 25 62. The pelletized material as claimed in either claim 60 or 61, wherein the pelletized material is for use in a moist or wet environment.
- 30 63. A powder composed of a polyamide molding composition as claimed in any one of claims 1 to 51, or composed of a polyamide mixture as claimed in any one of claims 52 to 59.
- 35 64. The powder as claimed in claim 63, which has an average grain size of from 30 to 200 μm .

65. The powder as claimed in either claim 63 or 64, whose solution viscosity at 0.5% by weight in m-cresol at 20°C is in the range of from 1.3 to 2.0.
- 5 66. The powder as claimed in claim 65, wherein the polyamide molding composition has been regulated.
67. The powder as claimed in claim 66, wherein the polyamide molding composition has been regulated
10 using a carboxy end group: amino end group ratio greater than or equal to 1:2 and respectively 2:1.
68. The powder as claimed in claim 67, wherein the polyamide molding composition has been regulated
15 using a carboxy end group: amino end group ratio greater than or equal to 1:3 and respectively 3:1.
69. The powder as claimed in any one of claims 63 to 68, which involves a mixture of oppositely
20 difunctionally regulated PA10T/6T composed of separately amine-regulated and carboxy-regulated powder particles.
70. The powder as claimed in any one of claims 63 to 69, which comprises, alongside 10T/6T copolyamide
25 particles, a further filler.
71. The powder as claimed in claim 70, wherein the further filler is in the form of solid or hollow
30 glass beads.
72. The powder as claimed in claim 71, wherein the glass beads have an average diameter of from 20 to 80 µm.
- 35 73. The use of a powder as claimed in any one of claims 63 to 72 in a selective laser-sintering process.

74. A molding produced using a polyamide molding composition as claimed in any one of claims 1 to 51, using a polyamide mixture as claimed in any one of
5 claims 52 to 59, using a pelletized material as claimed in any one of claims 60 to 62, or using a powder as claimed in any one of claims 63 to 72.
75. The molding of claim 74, produced using a powder as
10 claimed in any one of claims 63 to 72 in a selective laser-sintering process.
76. A process for the preparation of a polyamide molding composition as claimed in any one of claims 1 to 51,
15 which comprises adding, to the monomer mixtures, during the preparation of component (A), a proportion of from 0.005 to 1.5% by weight of at least one polycondensation catalyst.
- 20 77. The process of claim 76, wherein the at least one polycondensation catalyst comprises phosphorous compounds.
78. The process of claim 77, wherein the phosphorous
25 compounds are selected from the group consisting of: phosphoric acid, phosphorous acid, hypophosphorous acid, phenylphosphonic acid, phenylphosphinic acid, salts thereof with cations of valency from 1 to 3, esters thereof, and a mixture thereof.
- 30 79. The process of claim 78, wherein the esters are selected from the group consisting of: triphenyl phosphate, triphenyl phosphite, or tris(nonylphenyl) phosphite, and a mixture thereof.

80. The process as claimed in any one of claims 76 to 79, wherein the polycondensation catalyst involves hypophosphorous acid and sodium hydrogen hypophosphite monohydrate in an amount of from 100 to 500 ppm of phosphorus, based on the semiaromatic 10T/6T copolyamide (A).
81. The process as claimed in any one of claims 76 to 80, wherein, to compensate diamine loss, a diamine excess of from 1 to 8% by weight, based on the entirety of the diamines, is added to the monomer mixture.
82. The process as claimed in any one of claims 76 to 80, wherein, for regulation of the molar mass, of the relative viscosity and respectively of the flowability or the MVR, regulators are added to the mixture or to the precondensate, or to both.
83. The process as claimed in claim 82, wherein the regulators comprise monoacids, monoamines, or combinations thereof.
84. The process as claimed in claim 83, wherein the monoacids, monoamines, or combinations thereof are selected from the group consisting of: aliphatic, cycloaliphatic or aromatic monocarboxylic acids, or monoamines, or monofunctional compounds which can react with an amino group or acid group.
85. The process as claimed in claim 84, wherein the aliphatic, cycloaliphatic or aromatic monocarboxylic acids, or monoamines are selected from the group consisting of: acetic acid, propionic acid, butyric acid, valeric acid, caproic acid, lauric acid, stearic acid, 2-ethylhexanoic acid, cyclohexanoic

acid, benzoic acid, butylamine, pentylamine, hexylamine, 2-ethylhexylamine, n-octylamine, n-dodecylamine, n-tetradecylamine, n-hexadecylamine, stearylamine, cyclohexylamine, 3-(cyclohexylamino)propylamine, methylcyclohexylamine, dimethylcyclohexylamine, benzylamine, 2-phenylethylamine, and combinations thereof.

86. The process as claimed in claim 84, wherein the monofunctional compounds which can react with an amino group or acid group are selected from the group consisting of: anhydrides, isocyanates, acyl halides, or esters, and combinations thereof.

87. The process as claimed in any one of claims 82 to 86, wherein the amount of the regulators can be from 10 to 200 mmol/kg - regulator/polymer.

88. The process as claimed in claim 78, wherein the cations of valency from 1 to 3 are selected from the group consisting of: Na, K, Mg, Ga, Zn, Al, and mixtures thereof.

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1/2

Melting points of PA10T/6T

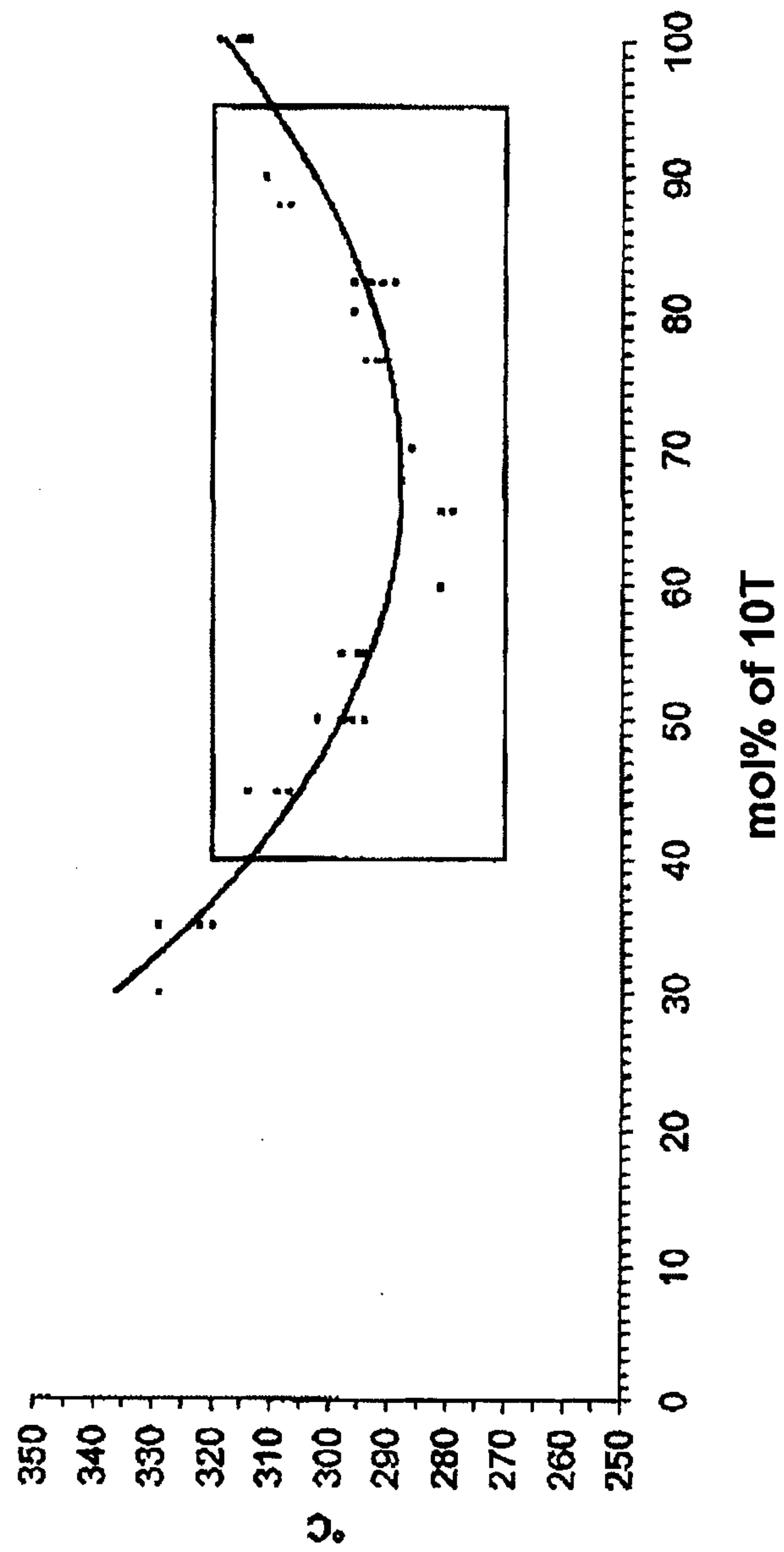


Fig. 1

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2/2

Water absorption of PA10T/6T

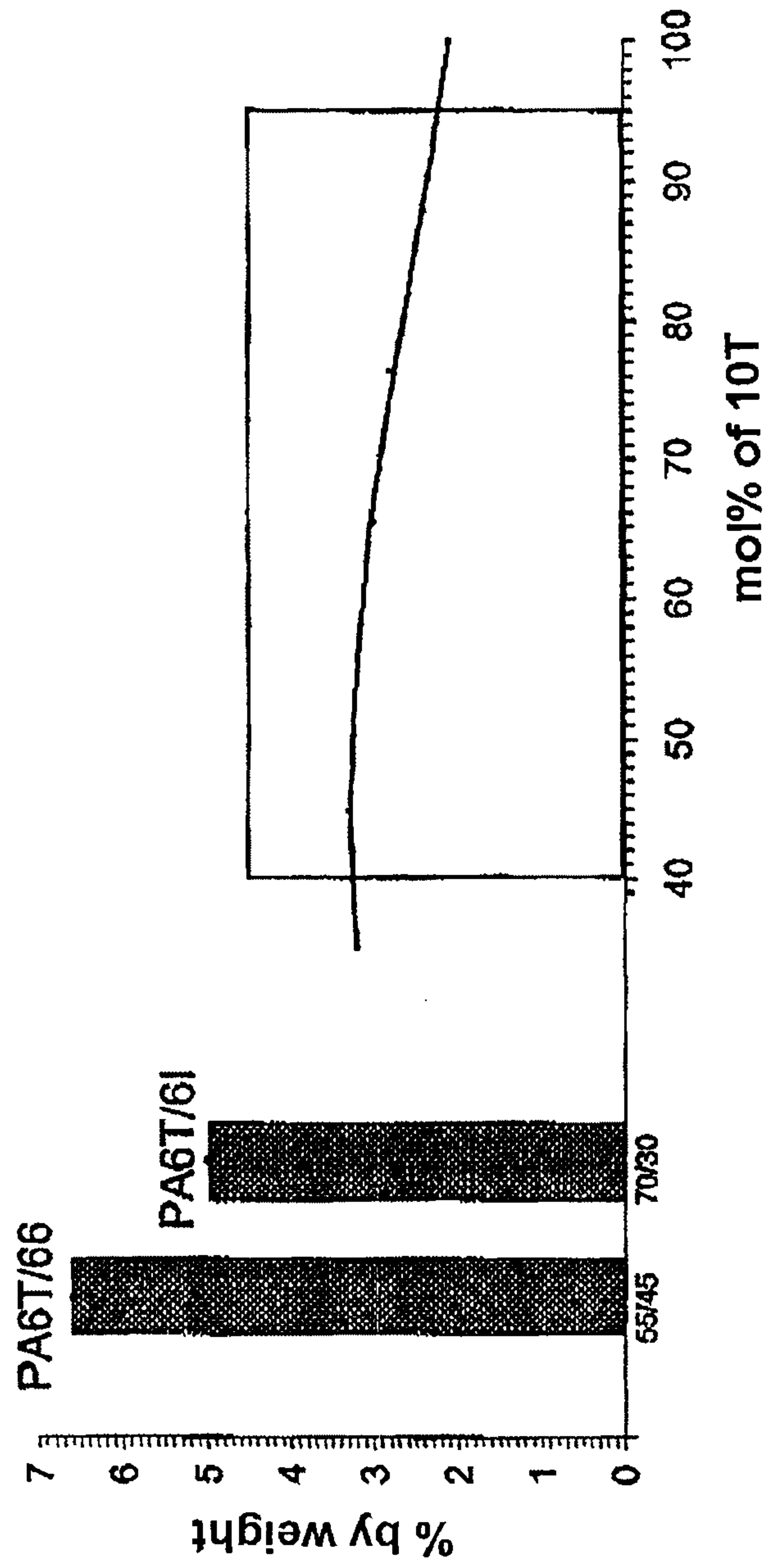


Fig. 2